Keysight W4630 and W4640 Series DDR4 BGA Interposers

Installation Guide

KEYSIGHT TECHNOLOGIES

Notices

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Keysight Technologies
1900 Garden of the Gods Road
Colorado Springs, CO 80907 USA

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CAUTION

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A WARNING notice denotes a hazard. It calls attention to an operating procedure, practice, or the like that, if not correctly performed or adhered to, could result in personal injury or death. Do not proceed beyond a WARNING notice until the indicated conditions are fully understood and met.

In This Guide

This guide provides installation and usage information for the following Keysight DDR4 BGA interposers and the cables used with these interposers.

W4630-series DDR4 DRAM BGA Interposers and cables

- W4633A DDR4 x4/x8 BGA Command and Data Interposer
- W4631A DDR4 x16 BGA Command and Data Interposer
- W4636A DDR4 x16 KOV BGA 2-Wings Command and Reduced Data Interposer
- E5849A High Data Rate Single-ended ZIF Cable (for use with the W4633A and W4631A interposers)
- E5847A High Data Rate Single-ended ZIF Cable (for use with the W4636A interposer)

W4640-series DDR4 DRAM BGA Interposers and cables

- W4643A DDR4 x4/x8 BGA 2-Wings Interposer
- W4641A DDR4 x16 BGA 2-Wings Interposer
- U4208A 61 pin ZIF for Left Wing, Probe/Cable Combination (for use with W4641A and W4643A interposers)
- U4209A 61 pin ZIF for Right Wing, Probe/Cable Combination (for use with W4641A and W4643A interposers)

DDR3 Probes

Keysight also offers equivalent probes for DDR3 memory:

- W3631A DDR3 x16 BGA address/control/data probe for stacked DRAM under 2G.
- W3633A DDR3 x4/x8 BGA address/control/data probe.
- W3636A DDR3 x16 non-stacked DRAM 96 ball BGA probe.
- E5845A adapter cable for W3631A and W3636A probes.
- E5847A adapter cable for W3633A probe.
- W3635B DDR3 oscilloscope probe adapter.

You can find installation and usage information for DDR3 probes in the *Keysight W3630-Series DDR3 DRAM BGA Probes Installation Guide* (part number *W3631-97004*). The guide is available for download on www.keysight.com.

Contents

1 Introduction to W4630-Series Interposers

This chapter introduces the hardware components that are needed for a W4630-series interposer setup. It also lists the software requirements as well as describes the mechanical considerations such as various dimensions and KOV that you should know before you start setting up and using these interposers.

W4630 Series DDR4 BGA Interposers – An Overview

The W4630-series DDR4 DRAM BGA Interposers enable probing of embedded DDR4 DRAM (x4, x8, and x16) directly at the ball grid array using the Keysight logic analyzers.

The DDR4 interposers interpose between the DRAM being probed and the PC board where the DRAM would normally be soldered. The interposer is designed to be soldered to the PCB footprint for the DRAM on top of either the DDR4 riser included with the W4630 series BGA interposer or an optional Grypper socket (not included with the interposer) or both. The DRAM being probed is then soldered to the top side of the interposer.

Each DRAM signal in the common footprint passes directly from the bottom side of the interposer to the top side of the interposer. Buried probe resistors placed at the DRAM balls connect the probed signals to the rigid flex to mate with the E5849A/E5847A cables.

Currently, in this series, Keysight provides the following interposers:

- W4633A DDR4 x4/x8 BGA interposers with 78 balls riser
- W4631A DDR4 x16 BGA interposer with 96 balls riser
- W4636A DDR4 x16 KOV BGA 2-Wings Command and Reduced Data interposer for 96 balls DDR4 DRAM

Compatibility with Logic Analyzer Modules

The W4630A series interposers are compatible with the following models of Keysight AXIe-based logic analyzer modules.

- U4154A
- U4154B
- U4164A

NOTE All W4630A series interposers are tested for via connections through the interposer and signal trace connectivity to the wing connections.

W4633A DDR4 x4/x8 BGA Interposer

The W4633A interposer has three flexible wings, each with a set of fingers for Zero Insertion Force (ZIF) connections that connect it to the E5849A single-ended ZIF probe adapter cables. These E5849A cables are then connected to the Logic Analyzer module's pods via U4201A logic analyzer cables.

The interposer comes with Resistor and Capacitor (RC) components installed on its top and bottom.

The following figure shows a W4633A DDR4 BGA interposer top side view, with RC components installed.

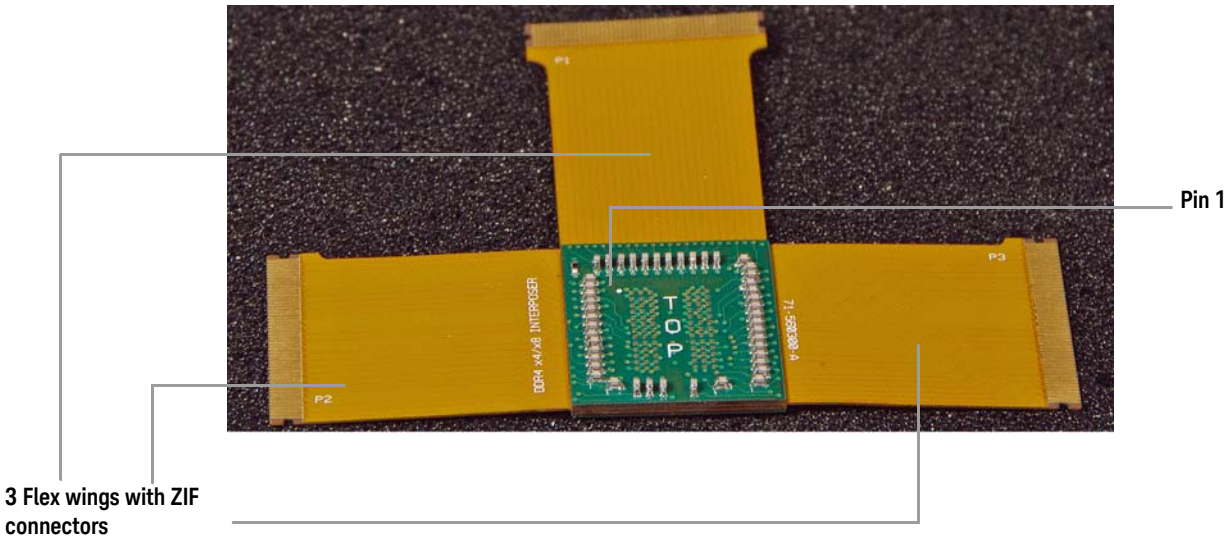


Figure 1 W4633A DDR4 x4/x8 BGA Interposer

W4633A Technical Features Summary

- Probes a 78 ball DDR4 single channel x4 or x8 DRAM chip, JEDEC MO-207M footprint variation DT-z. Maximum of 11 mm x 14 mm DDR4 DRAM package can fit on top of the W4633A interposer without an additional riser or a socket to provide clearance for the RC components.
- RC components network on the W4633A interposer:
  - ADD/CMD and half DATA RC on top of the interposer
  - Remaining half DATA RC on bottom of the interposer
- GND plane on the bottom side of the three flex wings of the interposer.
- For the three flex wings of the interposer, the recommended bend radius is 1.27MM (0.05") if flex is bent at a rigid portion of the interposer.
- Measurement timing skews within ±25 psec achieved by matched trace lengths from DDR4 balls to test point.
- Logic analyzer connections are made using E5849A single ended ZIF probe cables. Doors of ZIF connectors attach to the bottom side of flex wings of the interposer.

W4633A Riser and Optional Grypper Socket

A DDR4 78 ball riser is provided with each W4633A interposer to provide clearance for bottom-side RC components on the interposer and to allow the interposer to clear surrounding devices. Optionally, you can use a Grypper socket. It is not provided with the interposer.

The following figure displays a riser that is provided with the W4633A interposer.

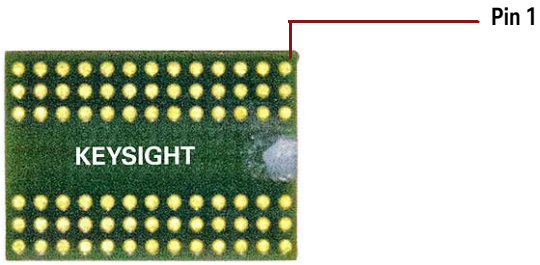


Figure 2 Riser that accompanies the W4633A interposer

NOTE

The DDR4 78 ball riser includes power and ground planes for optimal signal integrity. Due to the power and ground planes, the riser is only compatible with DDR4 78 ball DRAM.

To know how to solder the riser to the interposer and PC board, refer to the topic “Soldering the W4633A Interposer and Riser" on page 55.

W4631A DDR4 x16 BGA Interposer

The W4631A interposer has four flexible wings, each with a set of fingers for Zero Insertion Force (ZIF) connections that connect it to the right or left wing of the E5849A single-ended ZIF probe adapter cables. These E5849A cables are then connected to the Logic Analyzer module's pods via U4201A logic analyzer cables.

The interposer comes with Resistor and Capacitor (RC) components installed on its top and bottom.

The following figure shows a W4631A DDR4 BGA interposer top side view, with RC components installed.

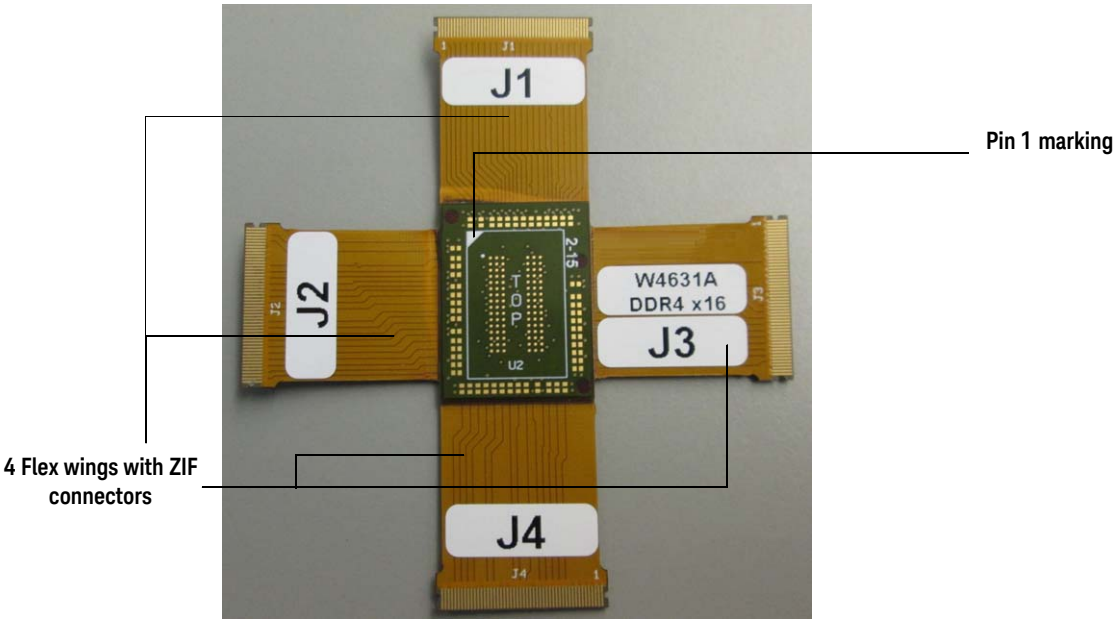


Figure 3 W4631A DDR4 x16 BGA Interposer

W4631A Technical Features Summary

- Probes a 96 ball DDR4 single channel x16 DRAM chip. Maximum of 12.5 mm x 19 mm DDR4 DRAM package can fit on top of the W4631A interposer without an additional riser or a socket to provide clearance for the RC components.
- RC components network on the W4631A interposer:
  - ADD/CMD and half DATA RC on top of the interposer
  - Remaining half DATA RC on bottom of the interposer
- GND plane on the bottom side of the four flex wings of the interposer.
- For the four flex wings of the interposer, the recommended minimum bend radius is 2.5 mm if flex is bent at a rigid portion of the interposer.
- Logic analyzer connections are made using E5849A single ended ZIF probe cables. Doors of ZIF connectors attach to the bottom side of flex wings of the interposer.

W4631A Riser and Optional Grypper Socket

A DDR4 96 ball riser is provided with each W4631A interposer to provide clearance for bottom-side RC components on the interposer and to allow the interposer to clear surrounding devices. Optionally, you can use a Grypper socket. It is not provided with the interposer.

The following figure displays the riser that is provided with the W4631A interposer.

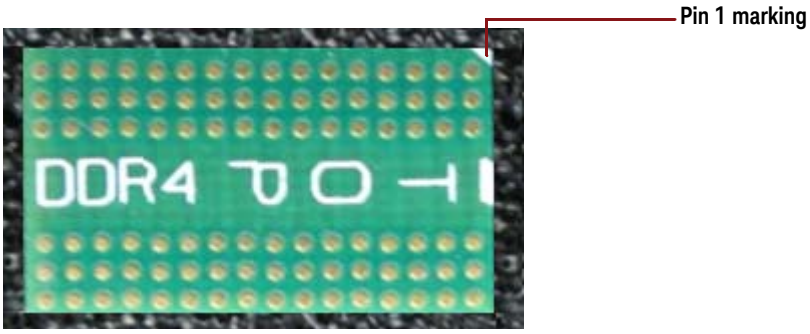


Figure 4 Riser that accompanies the W4631A interposer

CAUTION

The DDR4 96 balls riser includes power and ground planes for optimal signal integrity. Due to the power and ground planes, the riser is only compatible with DDR4 96 ball DRAM.

Attaching this riser to a DDR3 target system can result in damaging the target system.

To know how to solder the riser to the interposer and PC board, refer to the topic “Mounting a W4631A Interposer on a PC Board using Riser and/or Sockets" on page 65.

W4636A DDR4 x16 KOV BGA 2-Wings Command and Reduced Data Interposer

The W4636A interposer probes a 96-balls DDR4 DRAM. When compared to the W4631A x16 interposer, W4636A offers two wings with limited signal access, reduced data rates, and a smaller KOV.

This interposer is suitable for use in the following situations:

- For data rates up to and including 2.4 Gb/s.
- For capturing all ADD/CMD but partial DQ/DQS (DQ1-DQ7 are not routed). If you require access to all ADD/CMD/DQ/DQS at data rates over 2.4 Gb/s, then you can use the W4633A x4/x8 and W4631A x16 DDR4 BGA interposers.
- For minimal KOV in space-limited systems under test

The following figure shows a W4636A interposer's top side view.

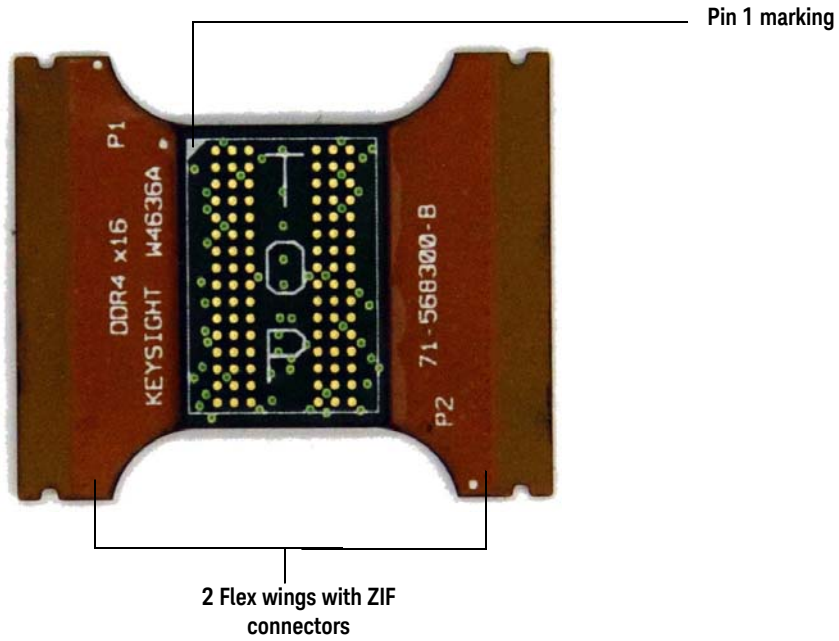


Figure 5 W4636A DDR4 x16 KOV BGA 2-Wings Command and Reduced Data Interposer

The W4636A interposer has two flexible wings, each with a set of fingers for Zero Insertion Force (ZIF) connections that connect it to the right or left wing of the E5847A single-ended ZIF probe adapter cables. These E5847A cables are then connected to the Logic Analyzer module's pods via U4201A logic analyzer cables.

In case of W4636A interposers, RC (resistor/capacitor) networks for logic analyzer probing are present on the E5847A ZIF cables and not on the interposer.

NOTE

No riser is required with the W4636A interposer. The interposer shipment, therefore, does not include any riser. You can optionally use a grypper socket which is sold separately at:

http://www.hsiotech.com/products/ released-products/engineering-products/grypper-family

W4636A Technical Features Summary

- Probes a 96 ball DDR4 single channel x16 DRAM chip. Maximum of 12.5 mm x 19 mm DDR4 DRAM package can fit on top of the W4636A interposer.
- No RC components network on the W4636A interposer:
- For the two flex wings of the interposer, the recommended minimum bend radius is 1.27 mm if flex is bent at a rigid portion of the interposer.
- Logic analyzer connections are made using E5847A single ended ZIF probe cables. Doors of ZIF connectors attach to the top side of flex wings of the interposer.

E5849A Single-ended ZIF Probe Cable

Two E5849A probe cables are required to connect a W4631A / W4633A interposer to a Logic Analyzer module using U4201A logic analyzer cables.

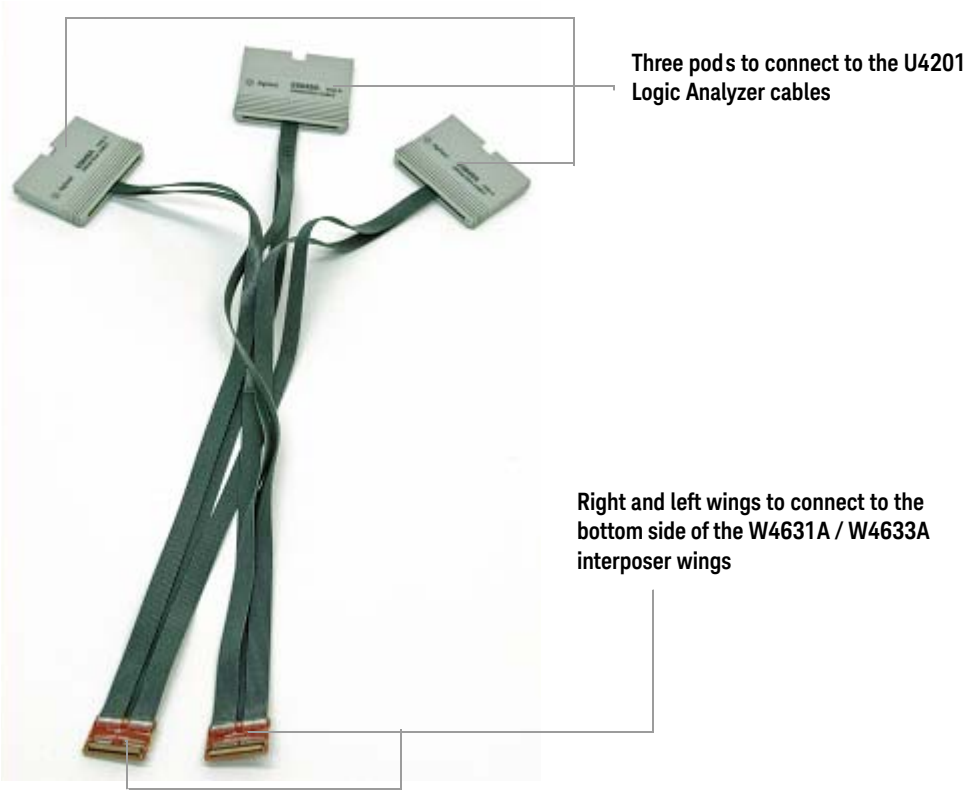


Figure 6 E5849A Single-ended ZIF probe cable

To know how to make connections between a W4631A or a W4633A interposer and E5849A probe cables, refer to the topics:

- "Connecting the W4631A Interposer to E5849A Probe Cables" on page 69
- "Connecting the W4633A Interposer to E5849A Probe Cables" on page 56

E5847A Single-ended ZIF Probe Cable

One E5847A probe cable is required to connect a W4636A interposer to a Logic Analyzer module using U4201A logic analyzer cables.

Figure 7 E5847A Single-ended ZIF probe cable

To know how to make connections between a W4636A interposer and an E5849A probe cable, refer to the topic:

- "Connecting the W4636A Interposer to an E5847A Probe Cable" on page 82

U4201A 90-pin Logic Analyzer Cables

The U4201A logic analyzer cable connects a **E5849A** or **E5847A** probe cable to a pod of the U4154A/B AXIe-based logic analyzer module.

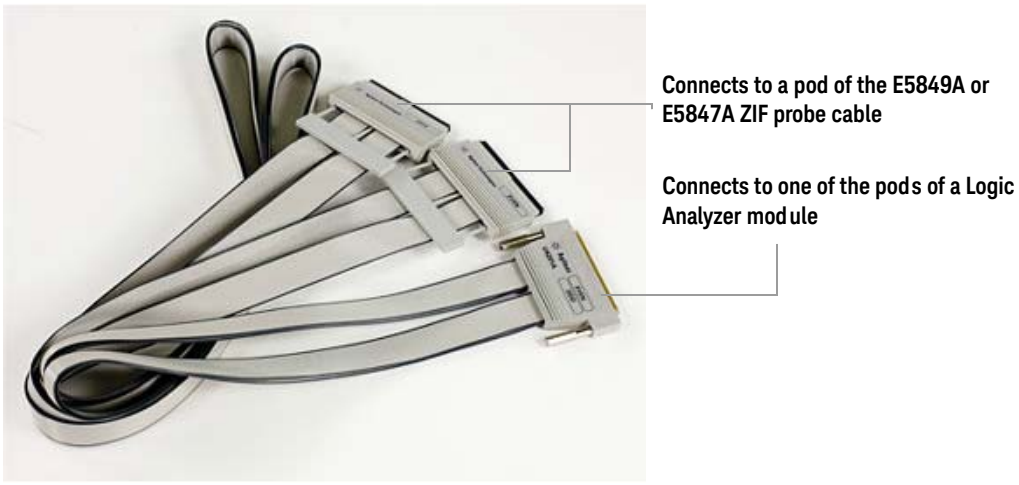


Figure 8 U4201A 90-pin logic analyzer cable

To know how to make connections between the U4201A cable and E5849A / E5847A probe cable, refer to the topics:

- "Connecting the E5849A Probe Cables to a Logic Analyzer" on page 73 (for W4631A)
- "Connecting the E5849A Probe Cables to a Logic Analyzer" on page 60 (for W4633A)
- "Connecting the E5847A Probe Cable to a Logic Analyzer" on page 85 (for W4636A)

Hardware and Software Requirements

Before you start installing the W4630-series probes, ensure that you have the following list of hardware and software components needed for these probes.

Hardware Requirements
U4154A /B AXIe-based Logic Analyzer Module(s)
M9502A 2-slot or M9505A 5-slot AXIe chassis to install the U4154A module(s)
M9536A embedded controller or host PC with PCI express adapter card for the chassis
W4630A Series DDR4 BGA Interposer(s)
E5849A 46-ch single-ended ZIF probe cables to connect the W4631A or W4633A interposer to U4201A Logic Analyzer cables Two E5849A cables needed for each interposer
E5847A 46-ch single-ended ZIF probe cables to connect the W4636A interposer to U4201A Logic Analyzer cables One E5847A cable needed for each interposer
U4201A 90-pin Logic Analyzer cables to connect the E5849A or E5847A probe cables to U4154A/B module's analysis pods - Four U4201A cables needed for each W4633A interposer - Four U4201A cables needed for each W4631A interposer. - Three U4201A cables needed for each W4636A interposer.

Software Requirements	Licensing	Description
Logic and Protocol Analyzer software version 5.80 or higher. (Mandatory)	Not Licensed	Base software platform for configuring and using Keysight's logic analyzer modules.
B4621B DDR 2/3/4 Bus Decoder software version 5.80 or higher. (Recommended)	Licensed	Allows you to decode and view transactions, commands, and data from a DDR2, DDR3, or DDR4 memory bus in your target system.
B4622B DDR 2/3/4 Protocol Compliance and Analysis toolset version 5.80 or higher. (Recommended)	Licensed	A set of tools to: ▪ evaluate and analyze the captured DDR data. ▪ perform real-time or post process compliance. ▪ set up a trigger on the specified address. ▪ graphically profile the distribution of memory accesses.
DDR Setup Assistant and DDR Eyefinder software version 5.80 or higher. (Recommended)	Not Licensed	A wizard- like application that helps you set up your U4154A logic analyzer properly for DDR/LPDDR memory technologies State mode measurements for ADD/CMD/DATA capture and analysis.

NOTE You can install the above-mentioned software components by downloading the required executables from the Keysight web site at: www.keysight.com/find/lpa-sw-download.

The following table displays the number of W4630A-series BGA interposers and cable adapters required to provide connections to channels of your logic analyzer module.

DRAM	Data Width	Access to	Number of Interposers	Number of ZIF Probes	Number of Cables	Number of Logic Analyzer Modules
x4	x4	Command, Address, Control and Data	One W4633A	Two E5849A	Four U4201A	One U4154A/B module
x8	x8					
x16	x16	Command, Address, Control and Data	One W4631A	Two E5849A	Four U4201A	One U4154A/B module for data rates up to and including 2.5 Gb/s
					Six U4201A	Two U4154A/B modules for data rates over 2.5 Gb/s
				1 DDR4 x16 ZIF cable ordered through Keysight AEO	Four U4201A	One U4154A/B module for all data rates
x16	x16	Command, Address, Control and partial DQ/DQS	One W4636A	One E5847A	Three U4201A	One U4154A/B module

Mechanical Considerations

W4633A Interposer Dimensions

The following figure shows the dimensions of a W4633A DDR4 DRAM BGA interposer.

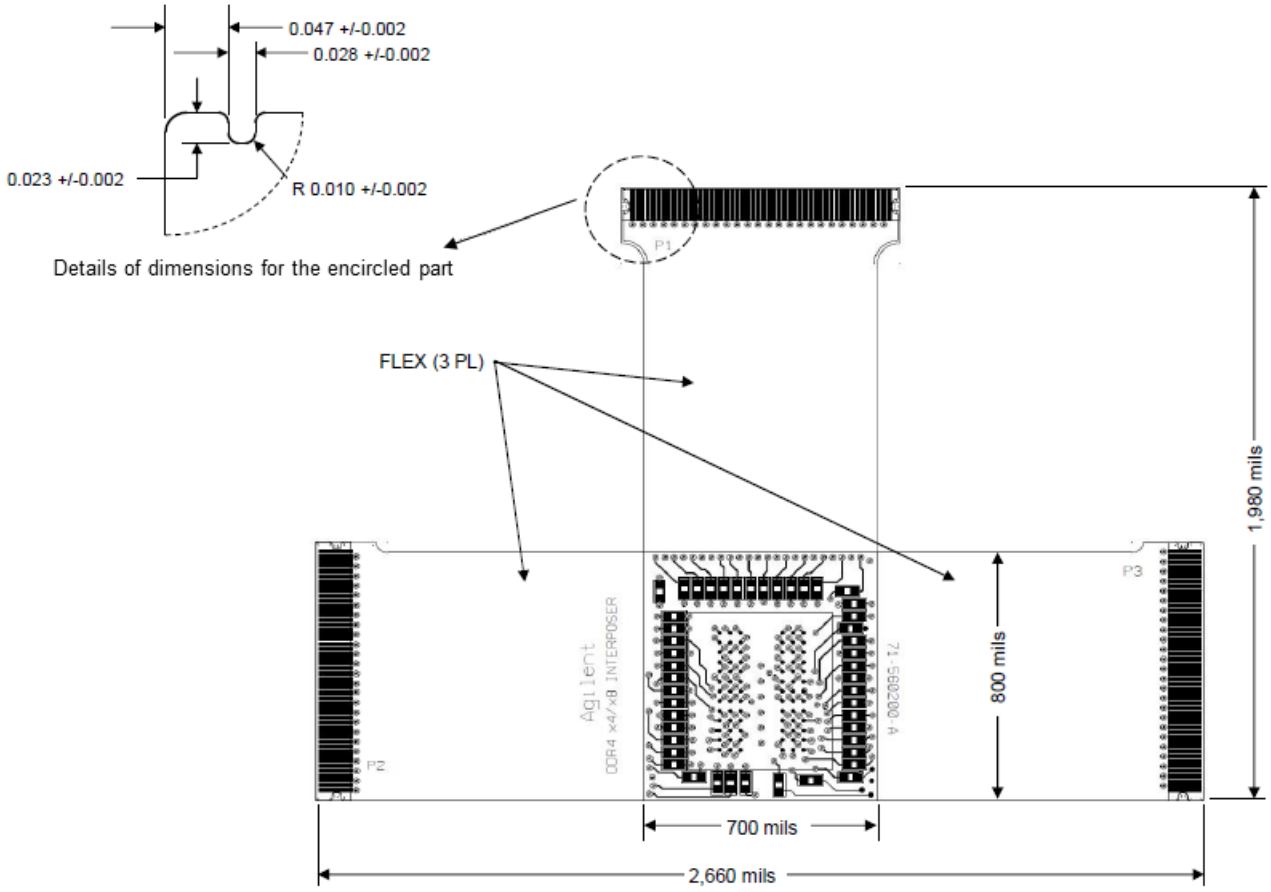


Figure 9 Dimensions of a W4633A interposer

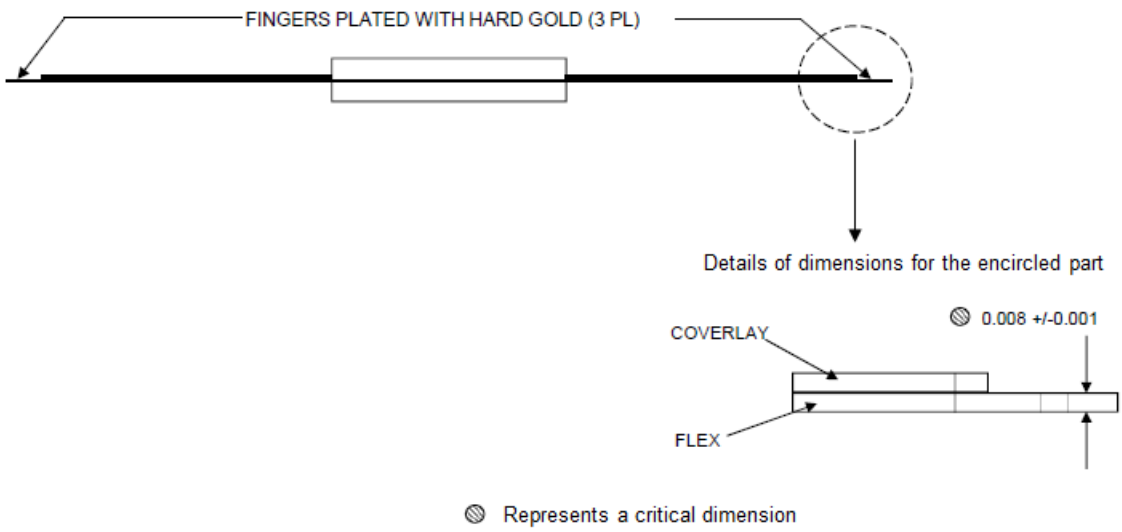


Figure 10 Dimensions of a W4633A interposer's signal finger

W4633A Keep-Out Volume

NOTE You must install the W4633A interposer on a riser (shipped with the interposer) or a grypper socket to provide clearance to surrounding DRAM and RCs on the bottom side of the interposer.

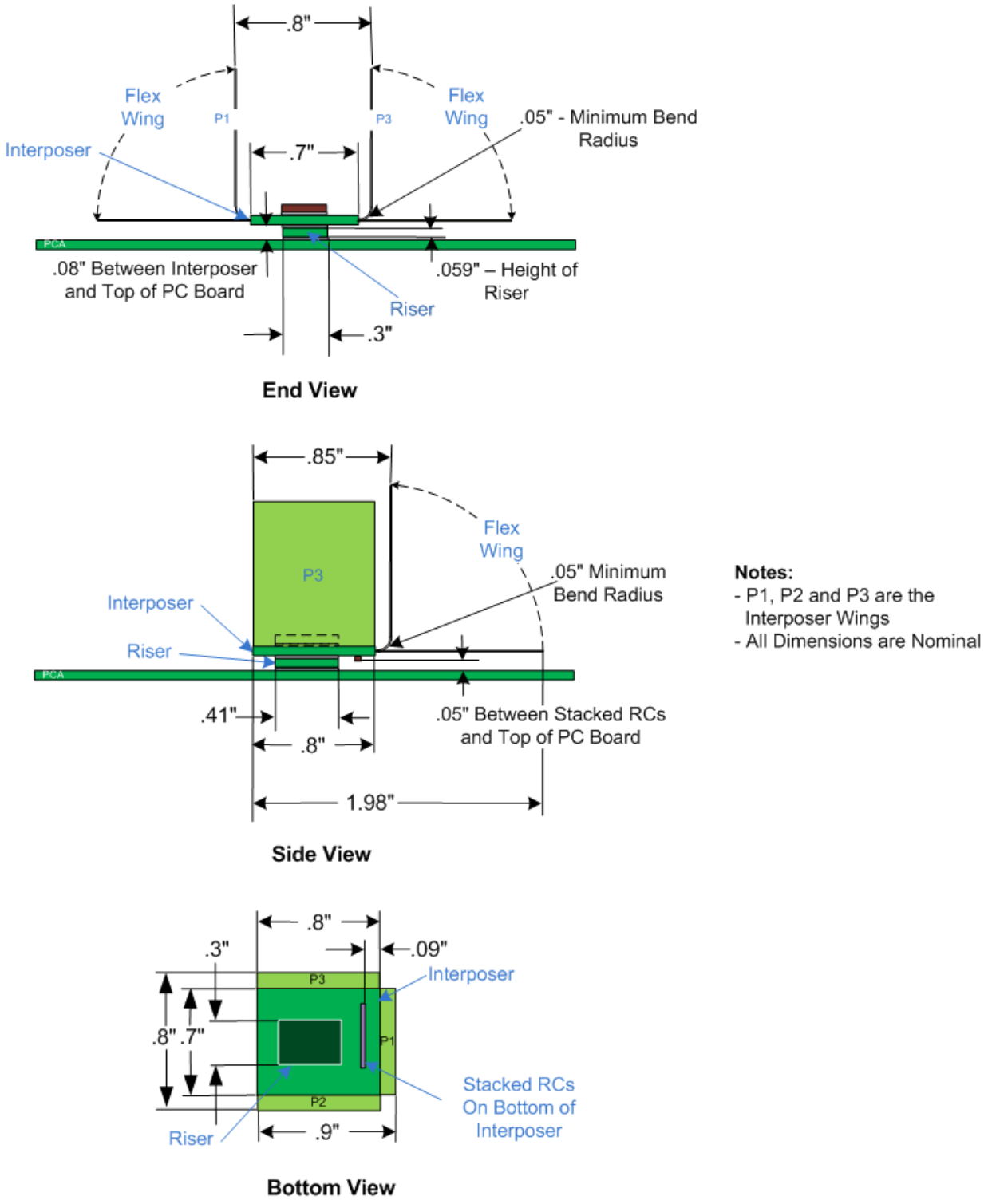


Figure 11 KOV of a W4633A interposer

The following figure shows the KOV of an E5849A probe cable when connected to a W4633A interposer.

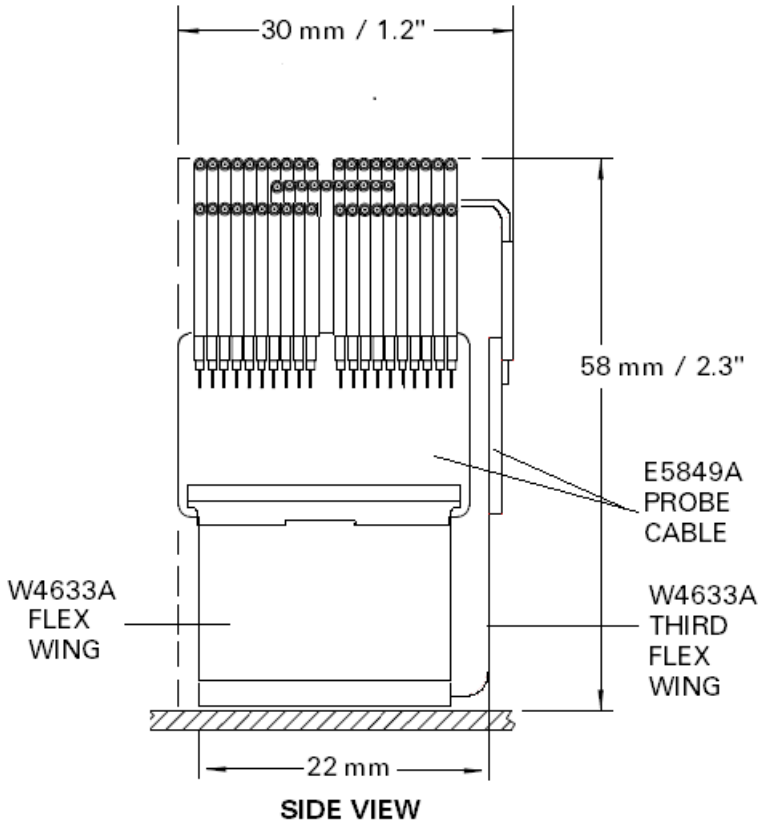


Figure 12 KOV of a W4633A interposer with an E5849A cable (SIDE VIEW)

W4631A Interposer Dimensions

The following figure shows the dimensions of a W4631A DDR4 DRAM BGA interposer.

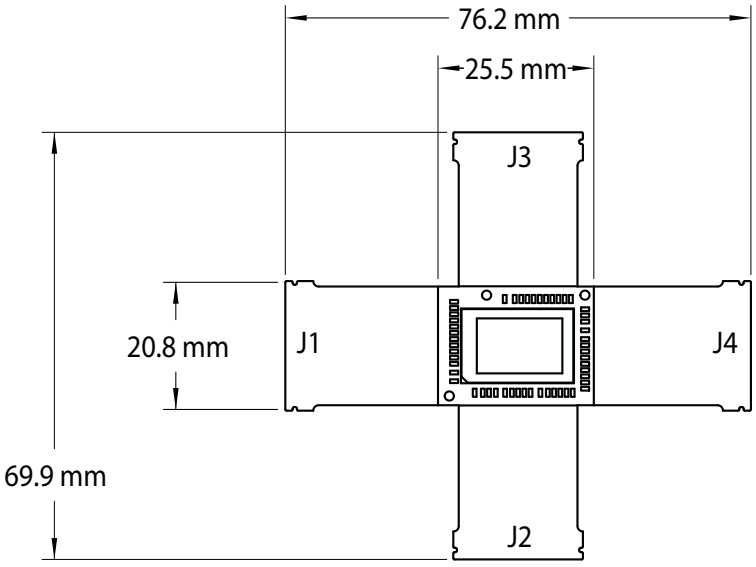
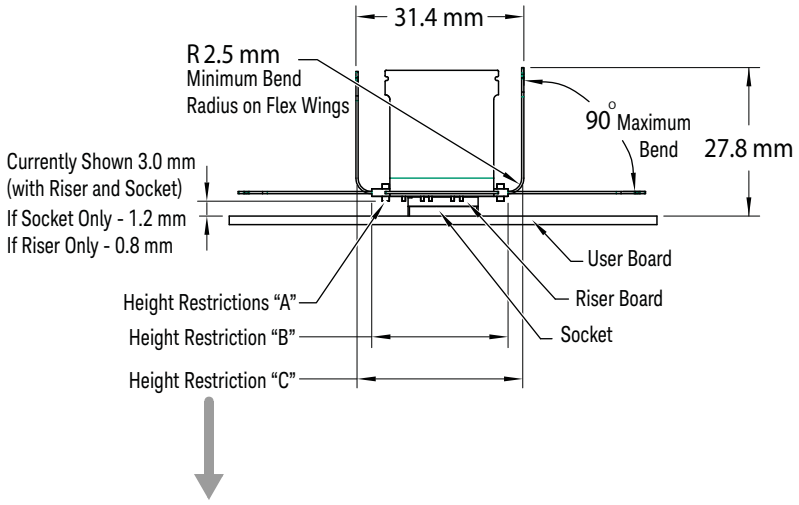


Figure 13 Dimensions of a W4631A interposer (TOP VIEW)

W4631A Keep-Out Volume

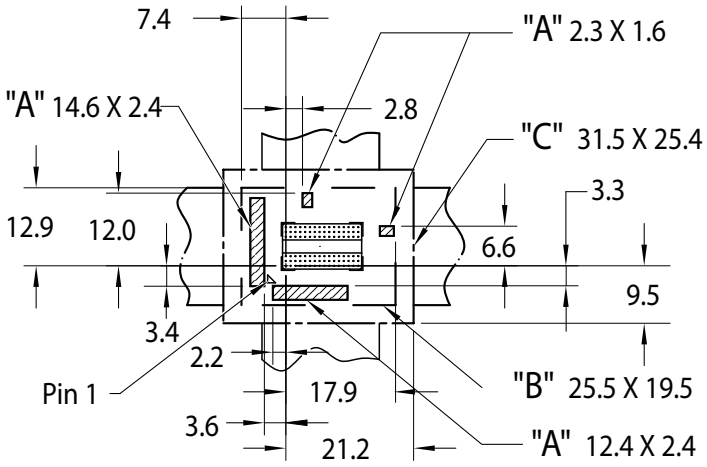
NOTE You must install the W4631A interposer on a riser (shipped with the interposer) or a grypper socket to provide clearance to surrounding DRAM and RCs on the bottom side of the interposer.



Height Restriction Areas Displayed in the Drawing Above	Height Restriction Applicable When using Both Riser and Socket	Height Restriction Applicable When Using Socket Only	Height Restriction Applicable When using Riser Only
"A"	3.0 mm	1.2 mm	0.8 mm
"B"	3.9 mm	2.1 mm	1.7 mm
"C"	4.4 mm	2.6 mm	2.2 mm

The height restrictions displayed above are the maximum height values above the user board within the areas A, B, and C.

Figure 14 Bend Radius and Height Restrictions as Displayed in a Side View of a W4631A interposer with all the Components Mounted



NOTES:

- All dimensions are in millimeters (mm).

- "A", "B", "C" represent height restriction areas on the user board. Refer to the previous figure to visualize these Height Restrictions Areas A, B, and C in the side view of a mounted W4631A interposer.

Figure 15 KOV of a W4631A interposer (BOTTOM VIEW)

W4636A Interposer Dimensions

The following figure shows the dimensions of a W4636A DDR4 DRAM BGA interposer. All dimensions are in millimeters.

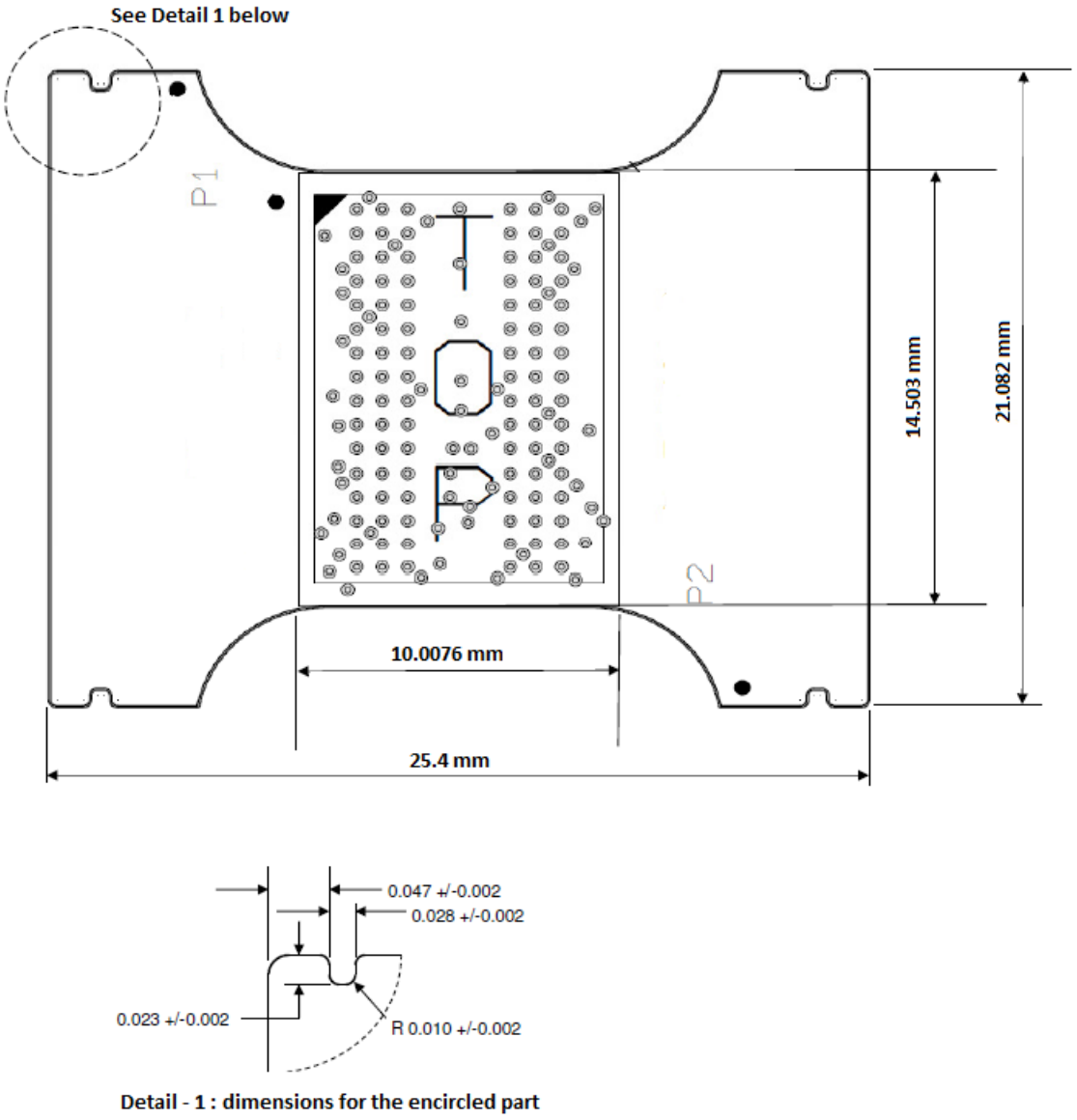
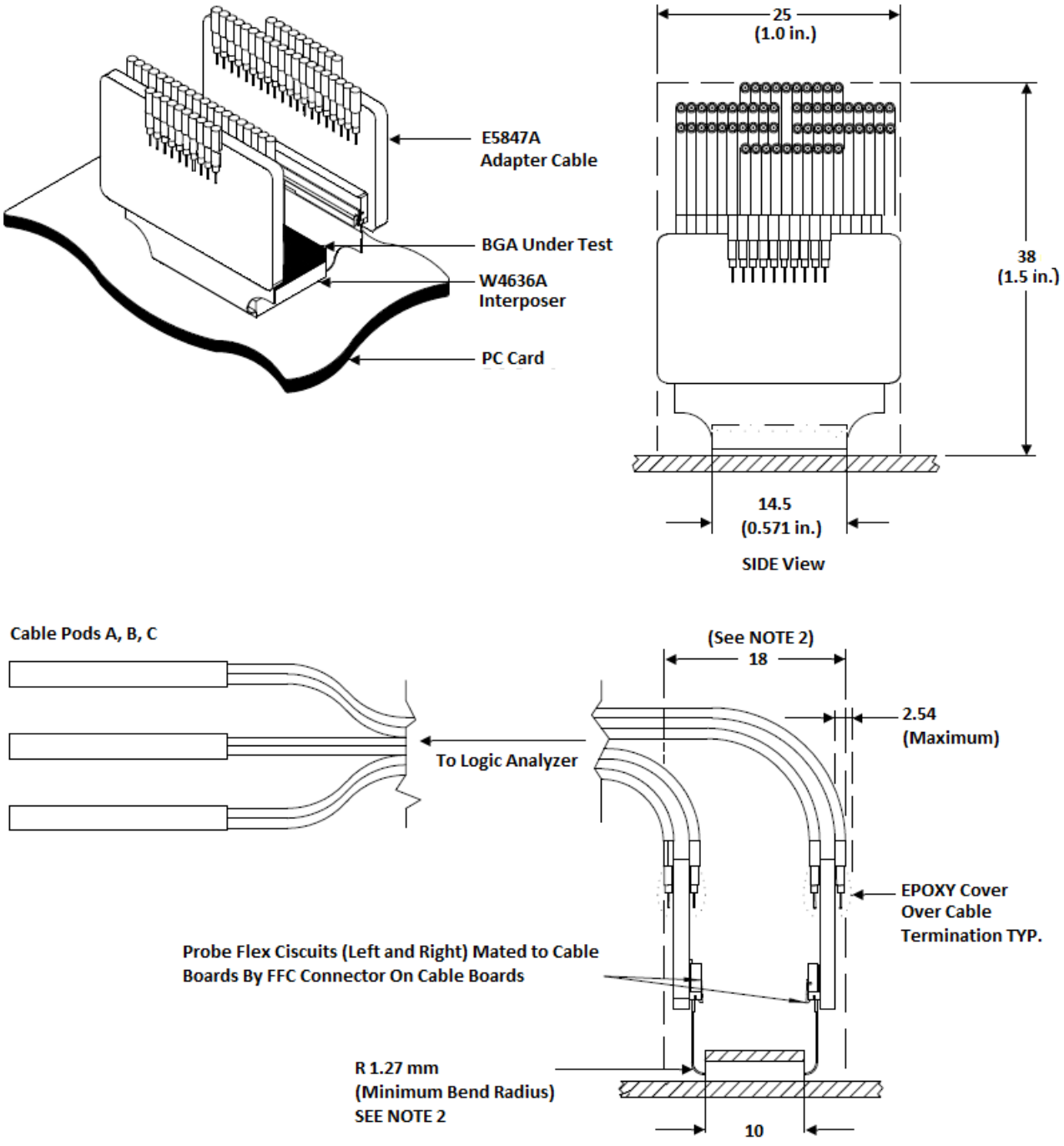


Figure 16 Dimensions of a W4636A interposer (TOP VIEW)

W4636A Keep-Out Volume

The following figure shows the KOV of an E5847A probe cable when connected to a W4636A interposer.



NOTES:

1. **W4636A Probe and E5847A Adapter Cable require the X, Y, Z space depicted on this drawing.**
2. **KOV width dimension is specified per minimum recommended Bend radius of 1.27 mm. If flex is bent flat to rigid portion of the probe, KOV width would be 53 mm (2.10 inches).**

Figure 17 KOV of a W4636A interposer with an E5847A cable

2 Introduction to W4640-Series Interposers

This chapter introduces the hardware components that are needed for a W4640-series interposer setup. It also lists the software requirements as well as describes the mechanical considerations such as various dimensions and KOV that you should know before you start setting up and using these interposers.

W4640-Series DDR4 BGA Interposers - An Overview

The W4640-series DDR4 DRAM BGA Interposers enable probing of embedded DDR4 DRAM (x4, x8, and x16) directly at the ball grid array using the Keysight U4164A logic analyzer. These interposers provide you:

- single touch probing of DQ and DM signals with separate RC networks
- higher data rate (greater than 3.2 Gb/s)
- smaller KOV

Using these interposers, you can capture DDR4 signals above 2.5Gb/s without double probe load.

A W4640-series interposer interposes between the DRAM being probed and the PC board where the DRAM would normally be soldered. The interposer is designed to be soldered to the PCB footprint for the DRAM on top of either the DDR4 riser included with the W4640 series BGA interposer or an optional Grypper socket (not included with the interposer) or both. The DRAM being probed is then soldered to the top side of the interposer.

Each DRAM signal in the common footprint passes directly from the bottom side of the interposer to the top side of the interposer. Buried probe resistors placed at the DRAM balls connect the probed signals to the rigid flex to mate with the U4208A/U4209A cables.

Currently, in this series, Keysight provides the following interposers:

- W4643A DDR4 x4/x8 BGA 2-Wings Interposer
- W4641A DDR4 x16 BGA 2-Wings Interposer

Compatibility with Logic Analyzer Modules

The W4640-series interposers are compatible with the Keysight U4164A AXIe-based logic analyzer module.

NOTE All W4640A series interposers are tested for via connections through the interposer and signal trace connectivity to the wing connections.

W4643A DDR4 x4/x8 BGA 2-Wings Interposer

The W4643A interposer probes a 78-ball x4/x8 DDR4 DRAM. This interposer is optimized to work with the U4164A logic Analyzer module to achieve higher data rates with smaller KOV as compared to the W4630-series interposers.

This interposer effectively utilizes the single touch probing and quad sampling features of the U4164A logic analyzer module thereby allowing you to probe DDR4 DQ signals above 2.5Gb/s without double probe load. (In quad sampling, four samples are captured per clock edge at two different thresholds. Two samples are taken at each threshold.

The W4643A interposer has two flexible wings, each with a set of fingers for Zero Insertion Force (ZIF) connections that connect it to a U4208A or a U4209A 61-pin ZIF probe/cable. For the left wing of the interposer, you use the U4208A probe/cable and for the right wing of the interposer, you use the U4209A probe/cable. These cables are then connected to the U4164A Logic Analyzer module's pods.

The following figure shows a W4643A DDR4 BGA interposer's top view.

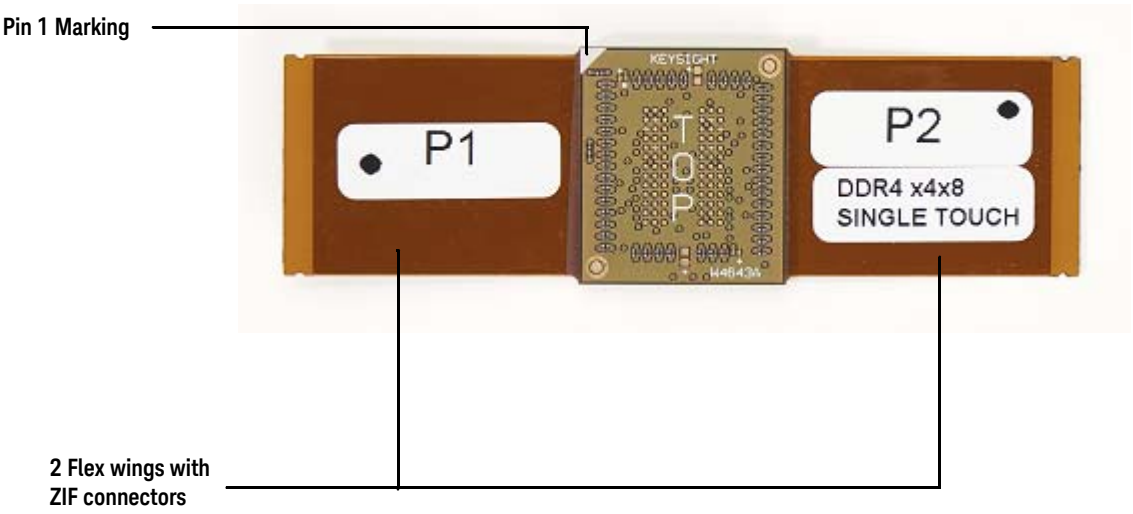


Figure 18 W4643A DDR4 x4/x8 BGA Interposer

W4643A Technical Features Summary

- Probes a 78 ball DDR4 single channel x4 or x8 DRAM chip. Maximum of 11 mm x 13 mm DDR4 DRAM package can fit on top of the W4643A interposer without an additional riser or a socket to provide clearance for the RC components.
- For the two flex wings of the interposer, the recommended bend radius is 1.27mm (0.05") if flex is bent at a rigid portion of the interposer.
- Logic analyzer connections are made using U4208A and U4209A ZIF probe cables. The U4208A/U4209A ZIF connectors doors open on the top of the W4643A wings and away from these wings.
- RC components network is present on the W4643A interposer. No RC network present on the U4208A/U4209A probe cables. Also, there are no RCs on the bottom of the interposer.

W4643A Riser and Optional Grypper Socket

A DDR4 78 ball riser is provided with each W4643A interposer to allow the interposer to clear surrounding devices. Optionally, you can use a Grypper socket. It is not provided with the interposer.

The following figure displays a riser that is provided with the W4643A interposer.

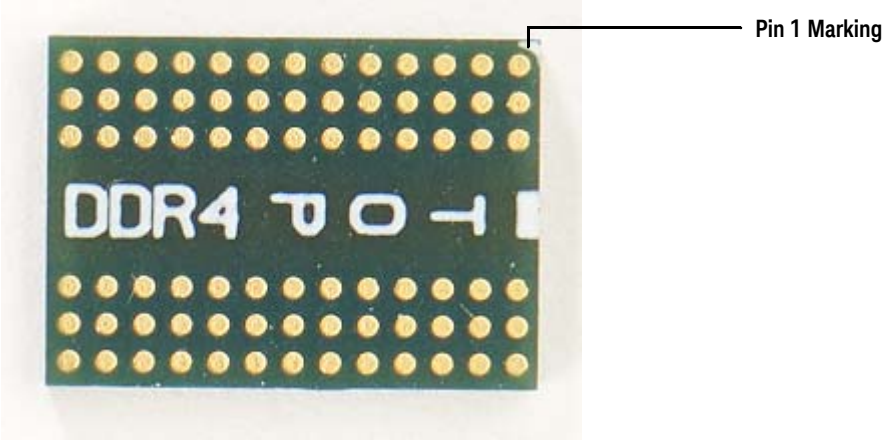


Figure 19 Riser that accompanies the W4643A interposer

NOTE The DDR4 78 ball riser includes power and ground planes for optimal signal integrity. Due to the power and ground planes, the riser is only compatible with DDR4 78 ball DRAM.

To know how to solder the riser to the W4643A interposer and PC board, refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

W4641A DDR4 x16 BGA 2-Wings Interposer

The W4641A interposer probes a 96-ball x16 DDR4 DRAM. This interposer is optimized to work with the U4164A logic Analyzer module to achieve higher data rates with smaller KOV as compared to the W4630-series interposers.

This interposer effectively utilizes the single touch probing and quad sampling features of the U4164A logic analyzer module thereby allowing you to probe DDR4 DQ signals above 2.5Gb/s without double probe load. (In quad sampling, four samples are captured per clock edge at two different thresholds. Two samples are taken at each threshold.)

The following figure shows a W4641A interposer's top side view.

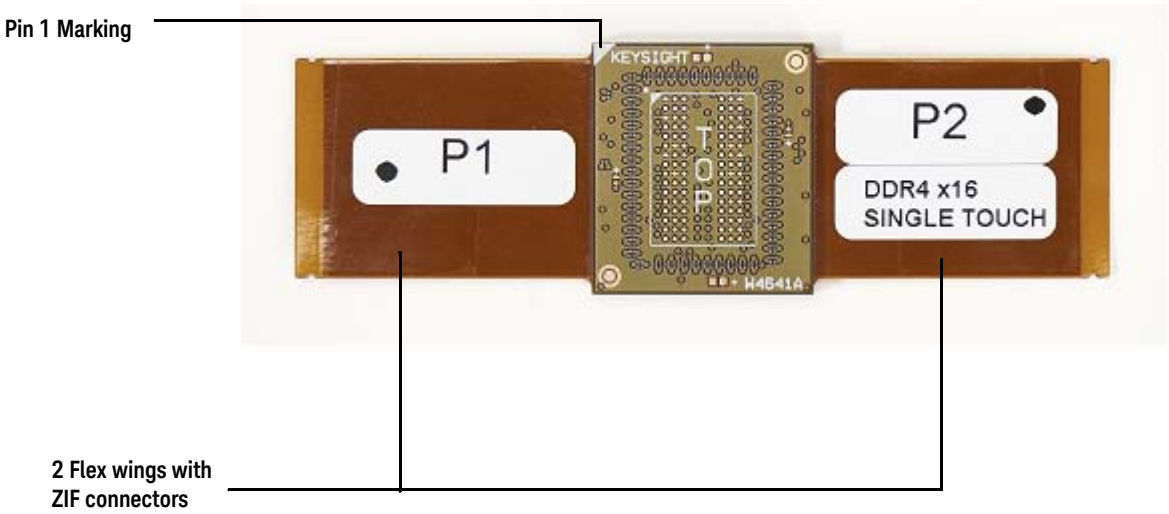


Figure 20 W4641A DDR4 x16 BGA 2-Wings Interposer

The W4641A interposer has two flexible wings, each with a set of fingers for Zero Insertion Force (ZIF) connections that connect it to a U4208A or a U4209A 61-pin ZIF probe/cable. For the left wing of the interposer, you use the U4208A probe/cable and for the right wing of the interposer, you use the U4209A probe/cable.These cables are then connected to the U4164A Logic Analyzer module's pods.

W4641A Technical Features Summary

- Probes a 96 ball DDR4 single channel x16 DRAM chip. Maximum of 10 mm x 14 mm DDR4 DRAM package can fit on top of the W4641A interposer.
- No RC network present on the U4208A/U4209A probe cables. RC network is present on the W4641A interposer. Also, there are no RCs on the bottom of the interposer.
- For the two flex wings of the interposer, the recommended minimum bend radius is 2.5 mm if flex is bent at a rigid portion of the interposer.
- Logic analyzer connections are made using U4208A and U4209A ZIF probe cables. The U4208A/U4209A ZIF connectors doors open on the top of the W4641A wings and away from these wings.

W4641A Riser and Optional Grypper Socket

A DDR4 96 ball riser is provided with each W4641A interposer to allow the interposer to clear surrounding devices. Optionally, you can use a Grypper socket. The following figure displays the riser that is provided with the W4641A interposer.

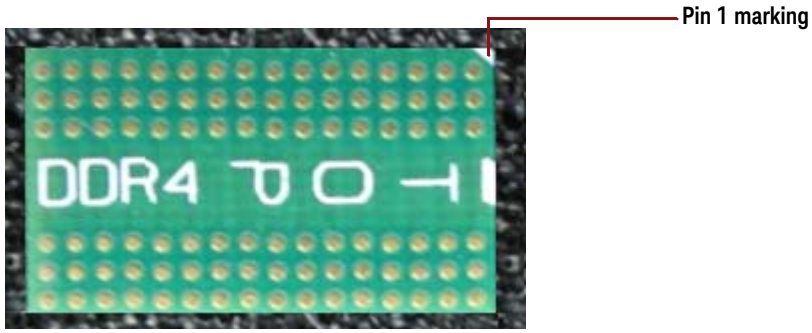


Figure 21 Riser that accompanies the W4641A interposer

CAUTION

The DDR4 96 balls riser includes power and ground planes for optimal signal integrity. Due to the power and ground planes, the riser is only compatible with DDR4 96 ball DRAM.

Attaching this riser to a DDR3 target system can result in damaging the target system.

To know how to solder the riser to the W4641A interposer and PC board, refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

U4208A 61-pin ZIF Probe / Cable (for Left Wing)

One U4208A probe cable is required to connect a W4641A or a W4643A interposer's left wing to a U4164A Logic Analyzer module.

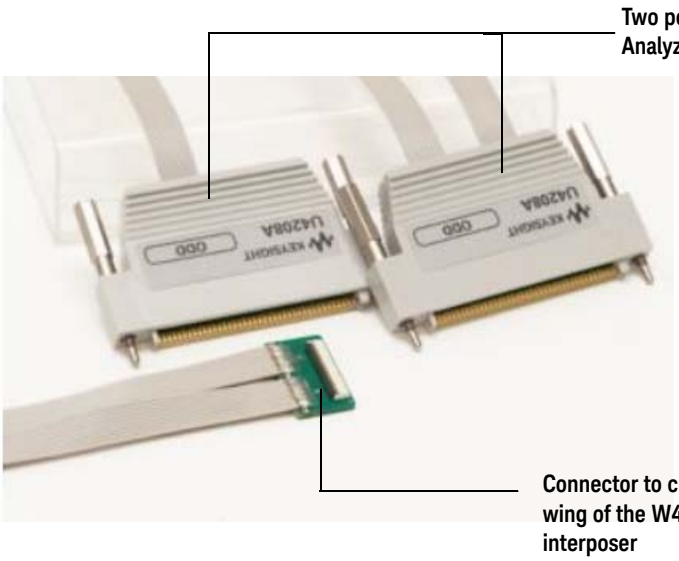


Figure 22 U4208A 61-pin ZIF probe cable

To know how to connect a W4641A or a W4643A interposer to a U4208A probe/cable, refer to the following topics in this guide:

- "Connecting the W4643A Interposer to U4208A and U4209A Probe Cables" on page 92
- "Connecting the W4641A Interposer to U4208A and U4209A Probe Cables" on page 102

To get information such as its characteristics, specifications, pinout, safety information, accessories, and dimensions of the U4208A probe/cable, refer to the *Keysight U4200A-Series Probes and Cables User Guide* (part number U4200-97000) available on www.keysight.com.

U4209A 61-pin ZIF Probe / Cable (for Right Wing)

One U4209A probe cable is required to connect a W4641A or a W4643A interposer's right wing to a U4164A Logic Analyzer module.

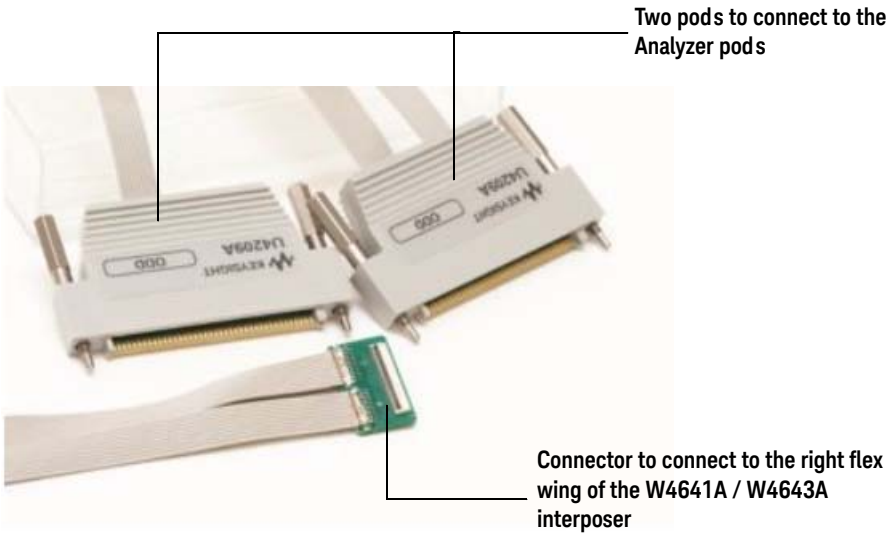


Figure 23 U4209A 61-pin ZIF probe cable

To know how to connect a W4641A or a W4643A interposer with a U4209A probe/cable, refer to the topics:

- "Connecting the W4643A Interposer to U4208A and U4209A Probe Cables" on page 92
- "Connecting the W4641A Interposer to U4208A and U4209A Probe Cables" on page 102

To get information such as its characteristics, specifications, pinout, safety information, accessories, and dimensions of the U4209A probe/cable, refer to the *Keysight U4200A-Series Probes and Cables User Guide* (part number U4200-97000) available on www.keysight.com.

Hardware and Software Requirements

Before you start installing the W4640-series probes, ensure that you have the following list of hardware and software components needed for these probes.

Hardware Requirements
U4164A AXIe-based Logic Analyzer Module
M9502A 2-slot or M9505A 5-slot AXIe chassis to install the U4144A module
M9536A embedded controller or host PC with PCI express adapter card for the chassis
W4640A Series DDR4 BGA Interposer(s)
U4208A 61-pin ZIF probe cables to connect the W4641A or W4643A interposer to Logic Analyzer module One cable needed for each interposer
U4209A 61-pin ZIF probe cables to connect the W4641A or W4643A interposer to Logic Analyzer module One cable needed for each interposer

Software Requirements	Licensing	Description
Logic and Protocol Analyzer software version 6.20 or higher. (Mandatory)	Not Licensed	Base software platform for configuring and using Keysight's logic analyzer modules.
B4661A-1FP DDR 2/3/4 Bus Decoder software version 6.20 or higher. (Recommended)	Licensed	Allows you to decode and view transactions, commands, and data from a DDR2, DDR3, or DDR4 memory bus in your target system.
B4661A-3FP DDR 2/3/4 Protocol Compliance and Analysis toolset version 6.20 or higher. (Recommended)	Licensed	A set of tools to: ▪ evaluate and analyze the captured DDR data. ▪ perform real-time or post process compliance. ▪ set up a trigger on the specified address. ▪ graphically profile the distribution of memory accesses.
B4661A-4FP DDR 2/3/4 Memory Analysis Viewer version 6.20 or higher. (Recommended)	Licensed	A viewer installed and displayed within the Logic and Protocol Analyzer GUI to analyze: ▪ memory traffic statistics. ▪ refresh rate and self-refresh periods. ▪ distribution of memory accesses. ▪ performance measurements for data transfer rates and memory utilization.
DDR Setup Assistant and DDR Eyefinder software version 6.20 or higher. (Recommended)	Not Licensed	A wizard- like application that helps you set up your U4154A logic analyzer properly for DDR/LPDDR memory technologies State mode measurements for ADD/CMD/DATA capture and analysis.

NOTE You can install the above-mentioned software components by downloading the required executables from the Keysight web site at: www.keysight.com/find/lpa-sw-download.

The following table displays the number of W4640-series BGA interposers and cables required to provide connections to channels of your logic analyzer module.

DRAM	Data Width	Access to	Number of Interposers	Number of ZIF Probes	Number of Logic Analyzer Modules
x4	x4	Command, Address, Control and Data	One W4643A	One U4208A for the left wing One U4209A for the right wing	One U4164A module
x8	x8				
x16	x16	Command, Address, Control and Data	One W4641A	One U4208A for the left wing One U4209A for the right wing	One U4164A module for all supported data rates

Mechanical Considerations

W4643A Interposer Dimensions

The following figure shows the dimensions of a W4643A interposer.

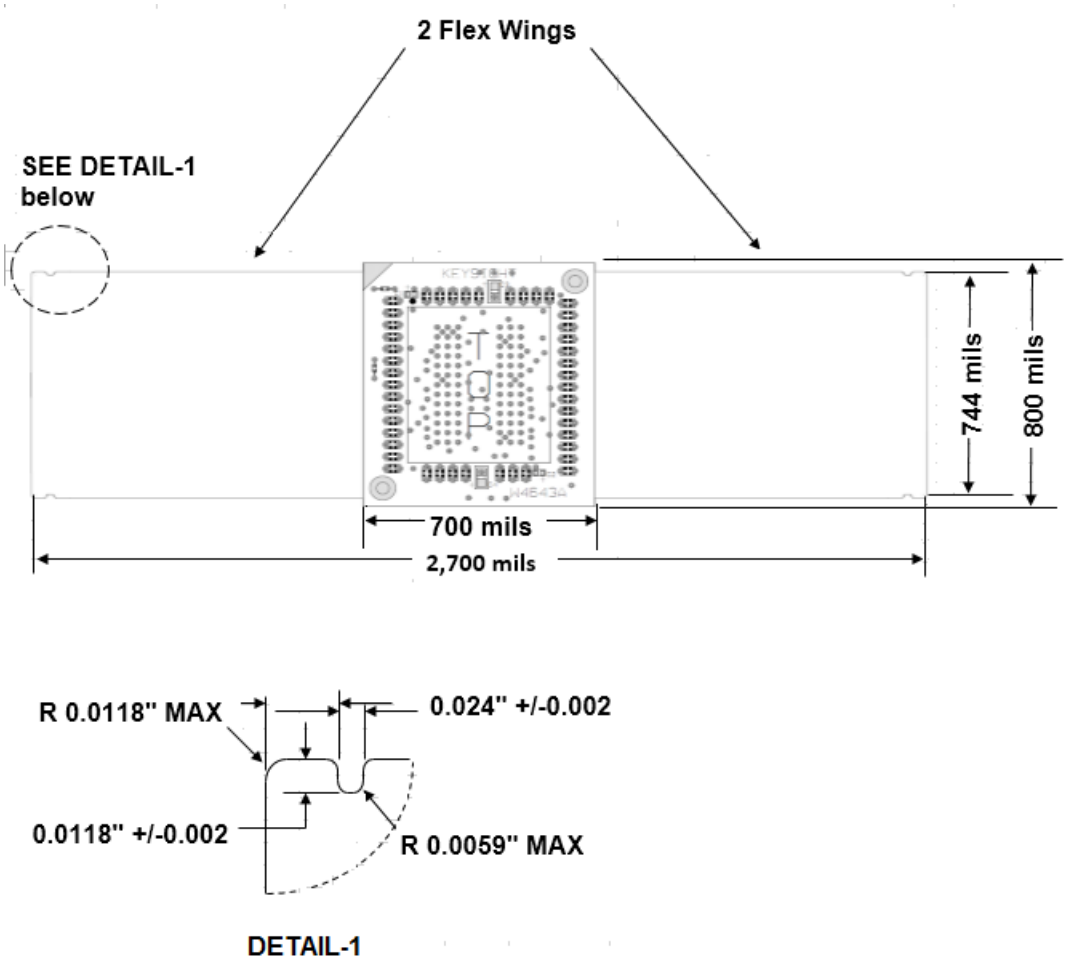
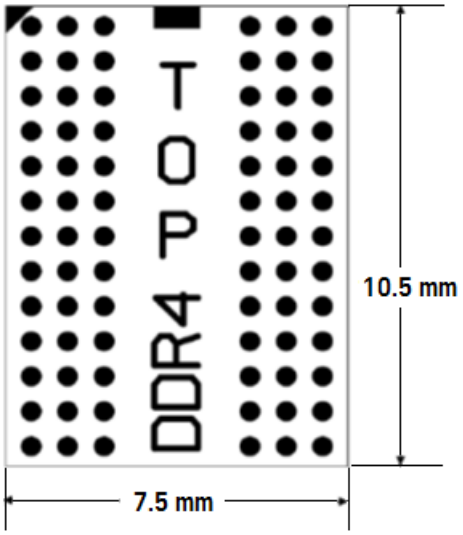


Figure 24 Dimensions of a W4643A interposer (TOP VIEW)

W4643A Riser Dimensions

All dimensions are in millimeters.



W4643A Keep-Out Volume

NOTE You must install the W4643A interposer on a riser (shipped with the interposer) or a grypper socket to provide clearance to surrounding DRAM.

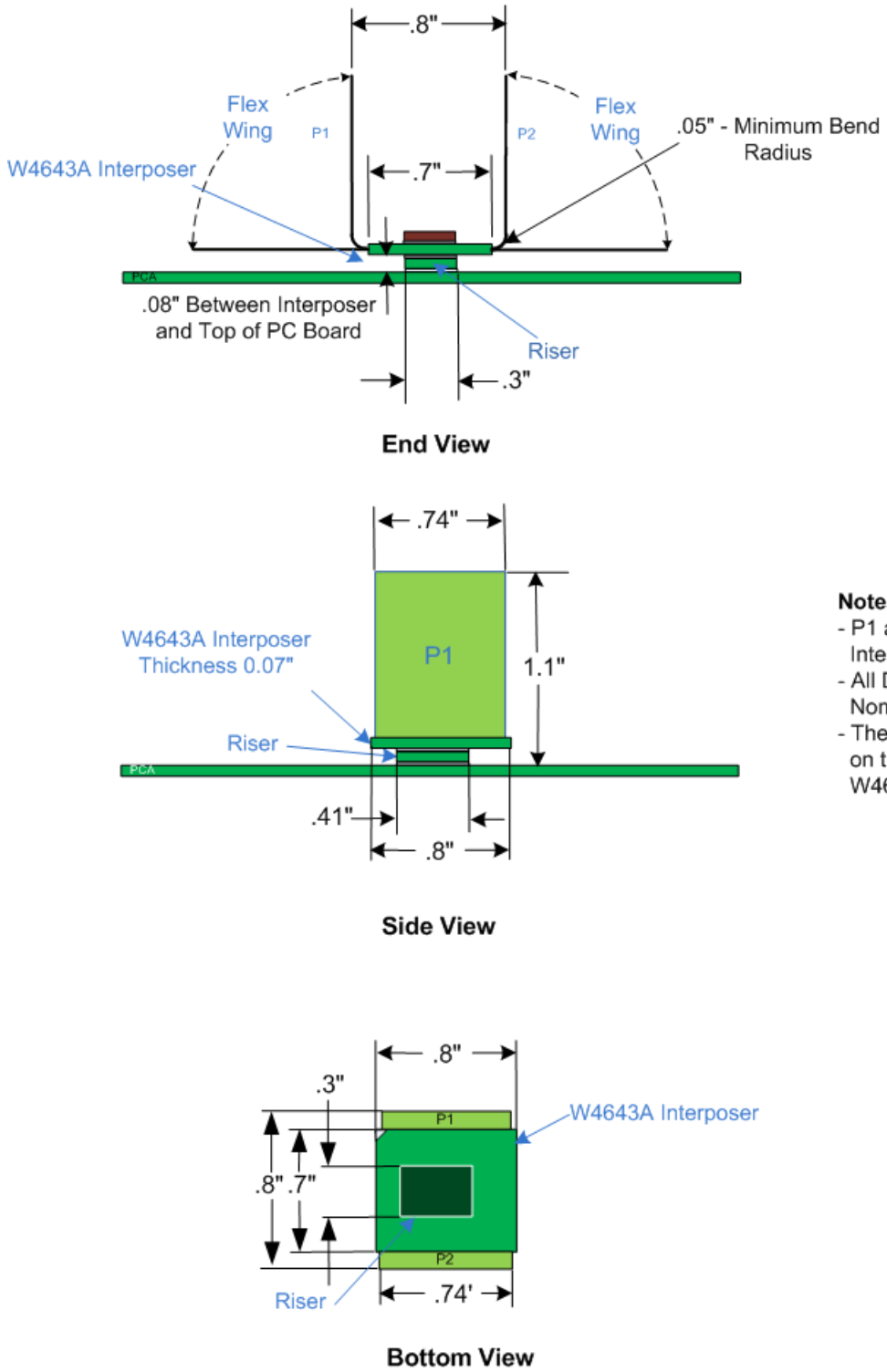


Figure 25 KOV of a W4643A interposer

W4641A Interposer Dimensions

The following figure shows the dimensions of a W4641A interposer.

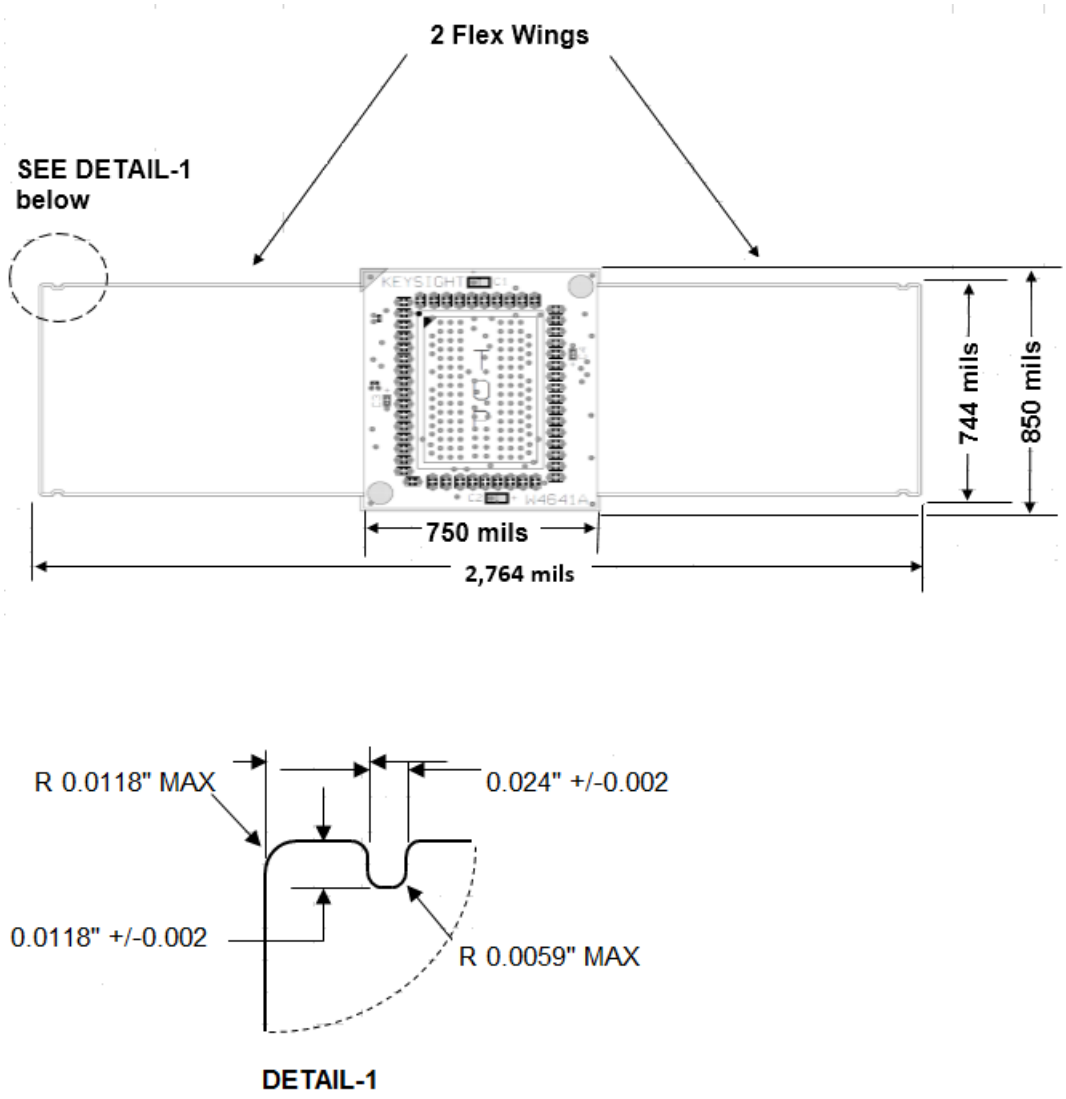
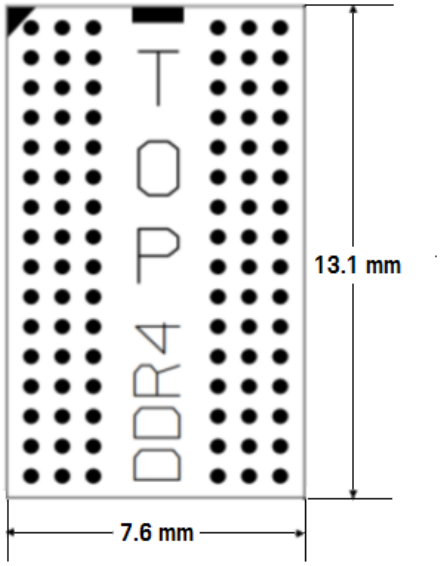


Figure 26 Dimensions of a W4641A interposer (TOP VIEW)

W4641A Riser Dimensions

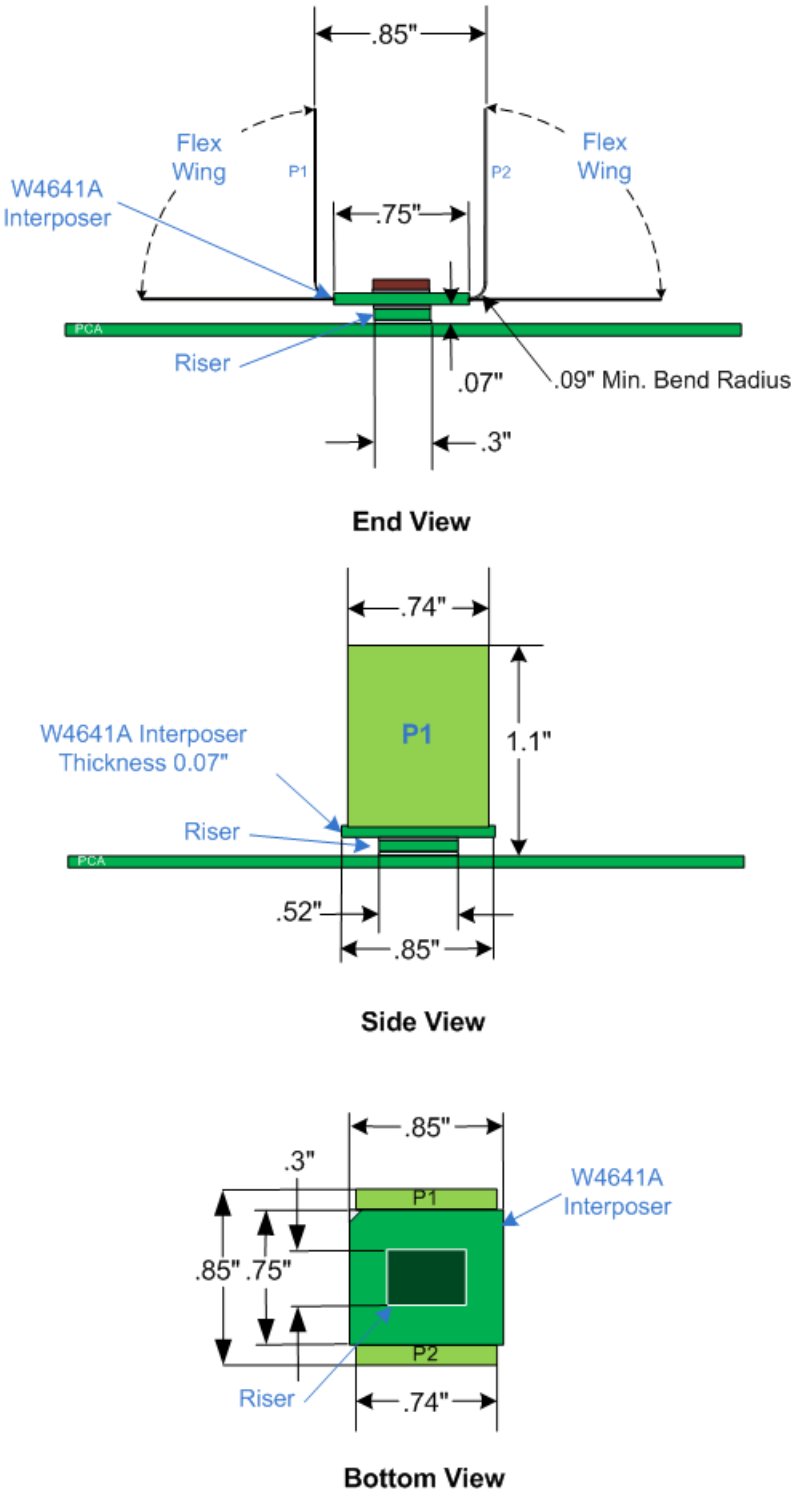
All dimensions are in millimeters.



1.52 mm Thickness

W4641A Keep-Out Volume

NOTE You must install the W4641A interposer on a riser (shipped with the interposer) or a grypper socket to provide clearance to surrounding DRAM.



Note:
- P1 and P2 are the Interposer Wings
- All Dimensions are Nominal
- There are no RCs on the bottom of the W4641A interposer

Figure 27 KOV of a W4641A interposer

3 W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines

In this chapter, Keysight provides the soldering guidelines and information for W4630-series and W4640-series BGA interposer installation. However, Keysight cannot guarantee the successful interposer installation due to variations in processes and equipment used at individual BGA rework facilities.

Keysight recommends that interposers be installed by companies with specific expertise in this advanced type of processing.

Keysight does not endorse any specific BGA rework facility but recommends using a reputable and experienced BGA rework facility for the installation of BGA interposers. The following links are provided as a convenience to users investigating BGA rework facilities.

Information on BGA Rework Facilities
Circuit Technology Center Haverhill, MA USA
BGA Rework and Repair Services http://www.circuitrework.com/services/bga.shtml
Keysight Technologies Adapter Rework http://www.circuitrework.com/features/671.shtml
eTech Round Rock, TX www.eTech-WEB.com
Singularity Electronic Systems Portsmouth, NH www.singularitysys.com

Recommended Reading
BGA Component Rework Procedures http://www.circuitrework.com/guides/9-0.shtml
BGA Component Rework Process Flow http://www.circuitrework.com/guides/9-1-1.shtml
BGA Component Rework Inspection http://www.circuitrework.com/guides/9-1-2.shtml
BGA Component Rework Profile Development, Standard Method http://www.circuitrework.com/guides/9-2-1.shtml
BGA Component Rework Profile Development, Smart Track Method http://www.circuitrework.com/guides/9-2-2.shtml
BGA Component Rework, Eutectic Solder Ball http://www.circuitrework.com/guides/9-3-1.shtml
BGA Component Reballing, Fixture Method http://www.circuitrework.com/guides/9-4-1.shtml

Recommended Soldering Guidelines

These guidelines are intended for anyone who has decided to install the winged BGA interposers themselves, or would like to provide guidelines to their regular contract manufacturer.

- The W4630-series and W4640-series interposers are assembled using lead free or leaded soldering processes.
- Observe standard lead-free rework guidelines and processes when applying DDR4 memory devices and attaching a riser to an interposer and DIMM.
- Typical time-above-liquidus (220°C in the case of SAC305 solder) is 30 to 90 seconds with 60 seconds as the good nominal target.
- The peak temperature at the SAC305 solder joints should be a minimum of 235°C.
- It is best to limit the peak temperature on the package of the IC at a maximum of 245°C.
- To minimize heating effects on components mounted on the interposer assembly, a leaded solder process can be used to attach a riser, when it is compatible with your prototype debug and validation methodologies.
- The flex wings on Keysight BGA interposers are made with Pyralux AP, the flex material, and Pyralux FR, the coverlay material with adhesive. Both of these materials have high moisture absorption characteristics, and always require baking prior to processing. Review the DuPont baking recommendation before processing.
- The maximum processing temperature that the W4630-series and W4640-series interposers can withstand is 260 °C for not more than 90 seconds.
- The W4630-series and W4640-series interposer are supplied without solder balls. Depending on the exact attachment order, either leaded or lead-free solder may be preferred to attach the interposer to the DUT. The design of the interposer supports either choice.
- The flexible “wings” on the interposer may need to be bent upwards before soldering to avoid mechanical contact with components adjacent to the interposer on the DUT. If interposer wings are bent during the soldering process, precautions must be taken to ensure that the wings do not move during the process. Applying heat to a bent wing has the tendency to cause the wing to relax and this can result in movement during the soldering process that can damage the integrity of the solder joints.

Soldering Steps

These steps and guidelines apply only to the proper method of attaching BGA interposers to their target host boards. These do not attempt to provide instructions on how to attach BGA balls to the interposer, nor do these attempt to suggest a flux or a solder paste process.

1 Profile Development
   - *a* Profile must conform to the solder paste specification. Use the lowest possible temperatures that will insure reflow.
   - *b* Profile must also provide a slow ramp up to temperature.
   - *c* It is recommended that the profile be developed using a non-functional sample interposer in a location on a sample target that is similar to the actual target.
   - *d* The highest processing temperature must be in the range of 240 °C to 260 °C. The maximum processing time at the highest temperature must not exceed 90 seconds.

2 Material Baking
   - *a* Prior to soldering, bake interposer (to eliminate moisture) for 2-10 hours at 250° F (121° C).
   - *b* Shield flex areas.
   - *c* Polyimide films absorb moisture quickly; therefore, soldering and reflow should be done within 30 minutes after baking.
   - *d* A 7 or 9 zone conventional oven is beneficial. A conventional oven is preferred over infra-red.
   - *e* Vacuum ovens are also used to remove water. Lower temperatures, such as 150-175 F (65-80 C) can be used. This method also reduces the oxidation of the exposed copper pads.
   - *f* After baking, if the units are not reflowed within a few hours, these should be re-baked or placed in a desiccant chamber.

3 Heat Shielding
   - *a* Kapton tape is applied to the bottom-side covering the gold contact area and wrapping around the outside edge to the top-side.
   - *b* Three layers of Kapton tape are applied to the top-side covering the entire wing extending over to the rigid board.
   - *c* Additional insulating of the wing area is done by applying a thick coating of the high temperature peelable masking to the Kapton tape covering the entire area to reduce the exposure to the hot gas heat cycle.

4 Host assembly components must be shielded using Kapton tape, aluminum heat shield blanket, or plates.

5 Site Preparation
   - *a* If the interposer is being installed onto a new board with gold pads, these pads should be pre-tin to ensure the pads wet properly, and to lower the chance of oxidation.
   - *b* Add solder paste to the target board using a mini-stencil. This is recommended over using flux only.

6 Interposer Reflow
   - *a* Use the lowest possible temp for reflow - Use a slow ramp up to temperature.
   - *b* Aim the shielded wings of the interposer upwards. The minimum bend radius must be 1.27mm (0.05 In) to insure that the copper foil does not fracture.
   - *c* Place the interposer using vision equipped BGA placement/reflow system such as an SRT.
   - *d* Reflow per the prepared heating profile.

7 Memory placement
   - *a* Add staking epoxy to the four corners of the placed interposer, and cure at 150°C for 2 minutes. This time is defined from the moment the adhesive reaches the cure temperature. As a convenience, the following link has been supplied on a staking adhesive.

https://tds.us.henkel.com/NA/UT/HNAUTTDS.nsf/web/7DA17BAB270FA76E882571870000D6EE/$File/3609-EN.pdf

b Apply solder paste to the top-side of interposer.

c Position memory using an SRT (or equivalent) with vision system for manual placement.

d Reflow per the prepared heating profile.

8 Post Processing

a Remove flux residue.

b Remove any Kapton tape heat shielding and peelable mask material.

c Remove heat shielding from the target board.

Interposer Fabrication Notes

Operating Environment

The W4630A-series and W4640-series interposers are constructed of polyimide material that supports solder attachment of the interposer using the higher temperatures required by a lead-free solder process. The coefficient of thermal expansion for the interposer is 55 ppm/degree C. When operating in a soldered-down environment over a wide range of temperatures, the expansion coefficient of the interposer, DRAM, and system being probed must be matched to avoid stress related failure of the solder connections between the Interposer and attached components. The interposer material allows operation over an industrial temperature range of -40 to +85 degrees Celsius (non-condensing), subject to the above constraint.

Mechanical Dimensions

When a W4631A / W4633A interposer is soldered to a riser, flatness must be maintained on the order of 3.5 mils or less across the BGA footprint to maximize successful soldering to the interposer.

4 Setting up the W4633A Interposer

W4633A Interposer Setup - Overview

1 Solder the riser, interposer, and memory components. (See page 55)
2 Connect the interposer flex wings to E5849A probe cables. (See page 56)
3 Connect the E5849A probe cables to a U4154A Logic Analyzer module's pods via U4201A logic analyzer cables. (See page 60)

CAUTION Use ESD precautions. Electrostatic discharge can damage components on your board or in the interposer. Use a grounded wrist strap and other ESD control measures as appropriate.

NOTE Do not open the vacuum sealed packs of the W4633A interposer until you are ready to install the interposer. Discard these packs once the package is opened.

Soldering the W4633A Interposer and Riser

The W4633A interposer needs to be attached to the DRAM PCB footprint on the design to be probed with either the riser soldered or an optional Grypper socket (not included with the interposer) installed in between the interposer and PC board. The desired DRAM is soldered to the top side of the interposer. The stack up of these soldered components is illustrated in the following figure.

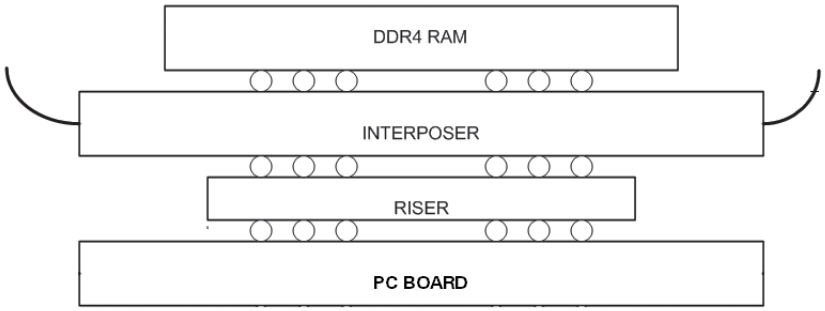


Figure 28 PC board, riser (or optional Grypper socket), interposer, and DRAM stack up

NOTE A maximum of 11 mm x 14 mm DDR4 DRAM package can fit on top of the W4633A interposer without an additional riser or a socket on the top of the interposer and under DRAM.

Refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

Connecting the W4633A Interposer to E5849A Probe Cables

After soldering the components or installing with a Grypper socket, you can start connecting the W4633A interposer to the E5849A probe cables.

NOTE **Please handle the interposer with care and ensure that the wings on the W4633A interposer are properly latched to the ZIF connectors on the E5849A probe cables.**

E5849A cables ship with labels unattached. Use the sheet of labels included with the E5949A to label one as "*Cable 1*" and a second as "*Cable 2*".

The following diagram illustrates how the interposer and E5849A cables have to be connected. As illustrated in this diagram:

- Two E5849A cables, *Cable 1* and *Cable 2* are used for a single W4633A interposer.
- The left and right wings of *Cable 1* connect to P1-Data and P2-Address/Command wings respectively of the interposer.
- The right wing of Cable 2 connects to P3-Address/Command wing of the interposer while the left wing of Cable 2 has not been used and left unconnected.

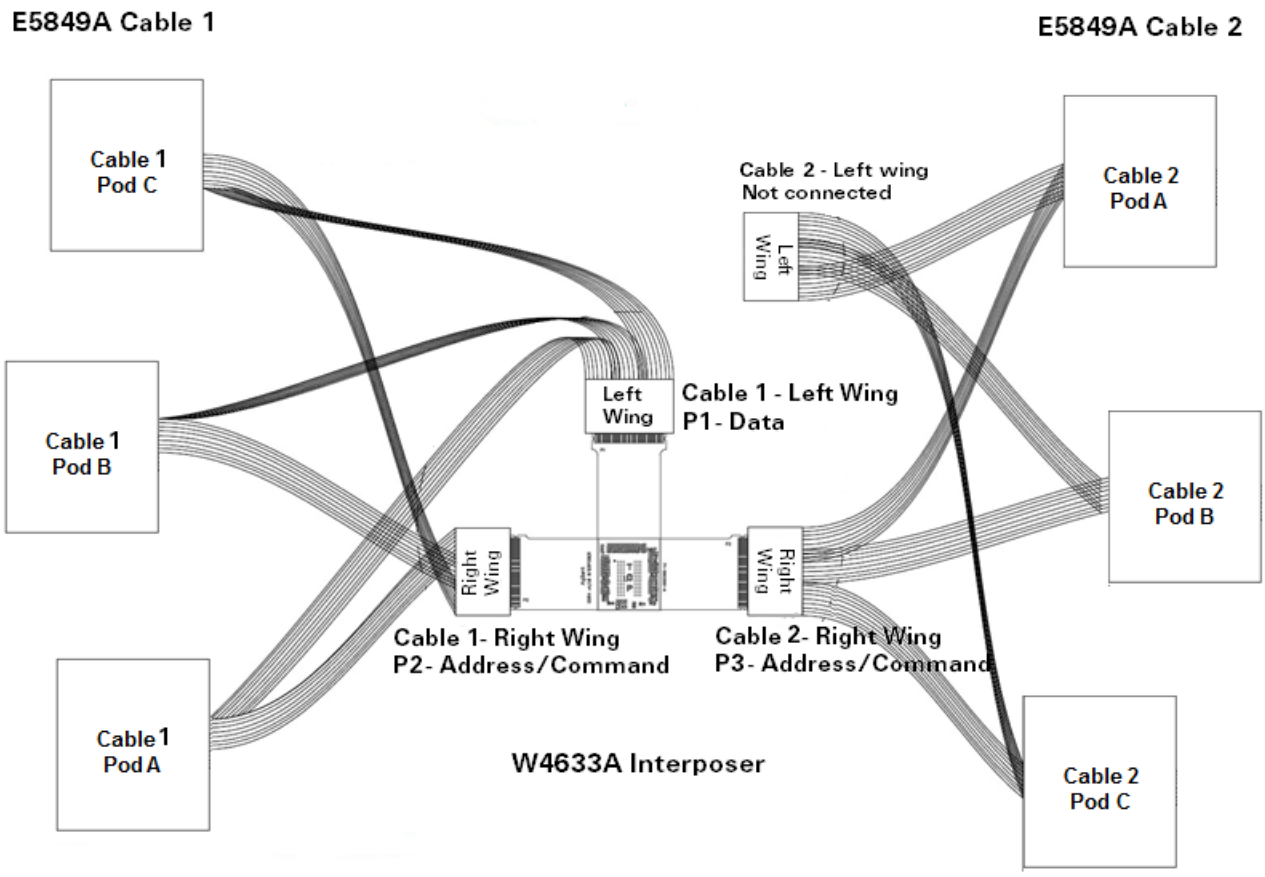


Figure 29 W4633A Interposer and E5849A Cable Connections

ZIF connectors on the E5849A cable connect to the bottom side of the flex wings on the W4633A interposer. ZIF doors close on the ground side of the flex wings. The following picture displays a W4633A interposer with E5849A ZIF connectors attached to its flex wings.

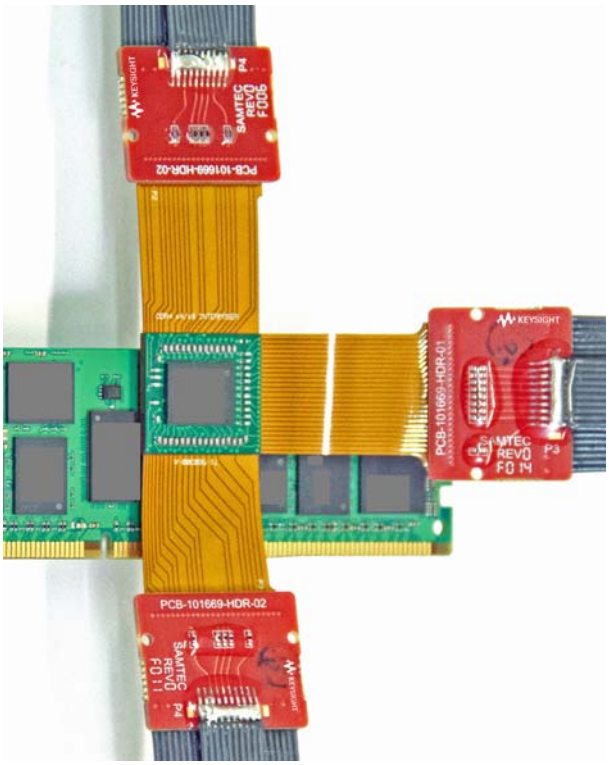
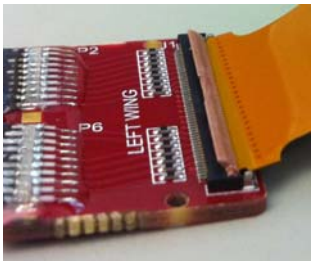


Figure 30 W4633A interposer attached to E5849A ZIF connectors

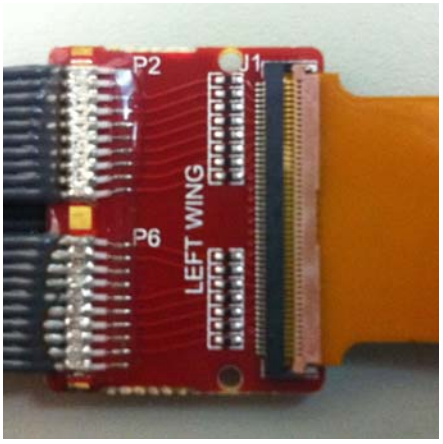
To attach an E5849A ZIF connector to a flex wing of the W4633A interposer, perform the following three steps.

1 Angle the flex wing of the interposer into an E5849A ZIF connector. GND towards door closure.



2 Align the E5849A ZIF connector tabs with interposer's wing notches.

3 Shut the ZIF door.



W4633A Interposer Wings Pinout

The following table lists the pinout of the three wings of a W4633A interposer.

Note: Clock inputs are highlighted with yellow in this table.

Table 1 W4633A Interposer Wings Pinout

Pin	W4633A Interposer Wings		
	J1- DATA	J2 - ADDRESS/COMMAND	J3 - ADDRESS/COMMAND
2	DQ4_2	A2	
4	DQ4_1	PAR	CS#
6	DQ0_2		C1
8	DQ0_1	A0	CAS#
10	TDQS#_2	A11	RAS#
12	TDQS#_1	A8	A12
14	DQS#_2	A6	
16	DQS#_1	BA0	BG1
18	DQS_2	A4	A3
20	DQS_1	RST#	
22	DQ2_2		
24	DQ2_1	PULLDN	
26	DQ6_2	CKE	
28	DQ6_1		BA1
30	DQ7_2		ALERT#
32	DQ7_1	BG0	A5
Pin	**E5849A Cable 1 Left Wing Connector**	**E5849A Cable 1 Right Wing Connector**	**E5849A Cable 2 Right Wing Connector**

Pin	W4633A Interposer Wings		
	J1 - DATA	J2 - ADDRESS/COMMAND	J3 - ADDRESS/COMMAND
34	DQ3_2	A10	A7
36	DQ3_1	WE#	
38	DQ1_2	ACT#	A1
40	DQ1_1	C0	A13
42	DM#_2		CK
44	DM#_1		CK#
46	DQS_2	C2	A17
48	DQS_1	ODT	A9
50	GND	GND	GND
ODD	GND	GND	GND
Pin	E5849A Cable 1 Left Wing Connector	E5849A Cable 1 Right Wing Connector	E5849A Cable 2 Right Wing Connector

Connecting the E5849A Probe Cables to a Logic Analyzer

In a W4633A interposer setup, you make connections between an E5849A probe cable and a U4154A logic analyzer module by:

- First connecting the E5849A probe cable to a U4201A cable.
- Then connecting this U4201A cable to the relevant Logic Analyzer pod on the front panel of the U4154A module.

The following figure displays the relevant U4154A Logic Analyzer pods that you need to use to connect the right and left wings of the two E5849A probe cables used in a W4633A interposer setup.

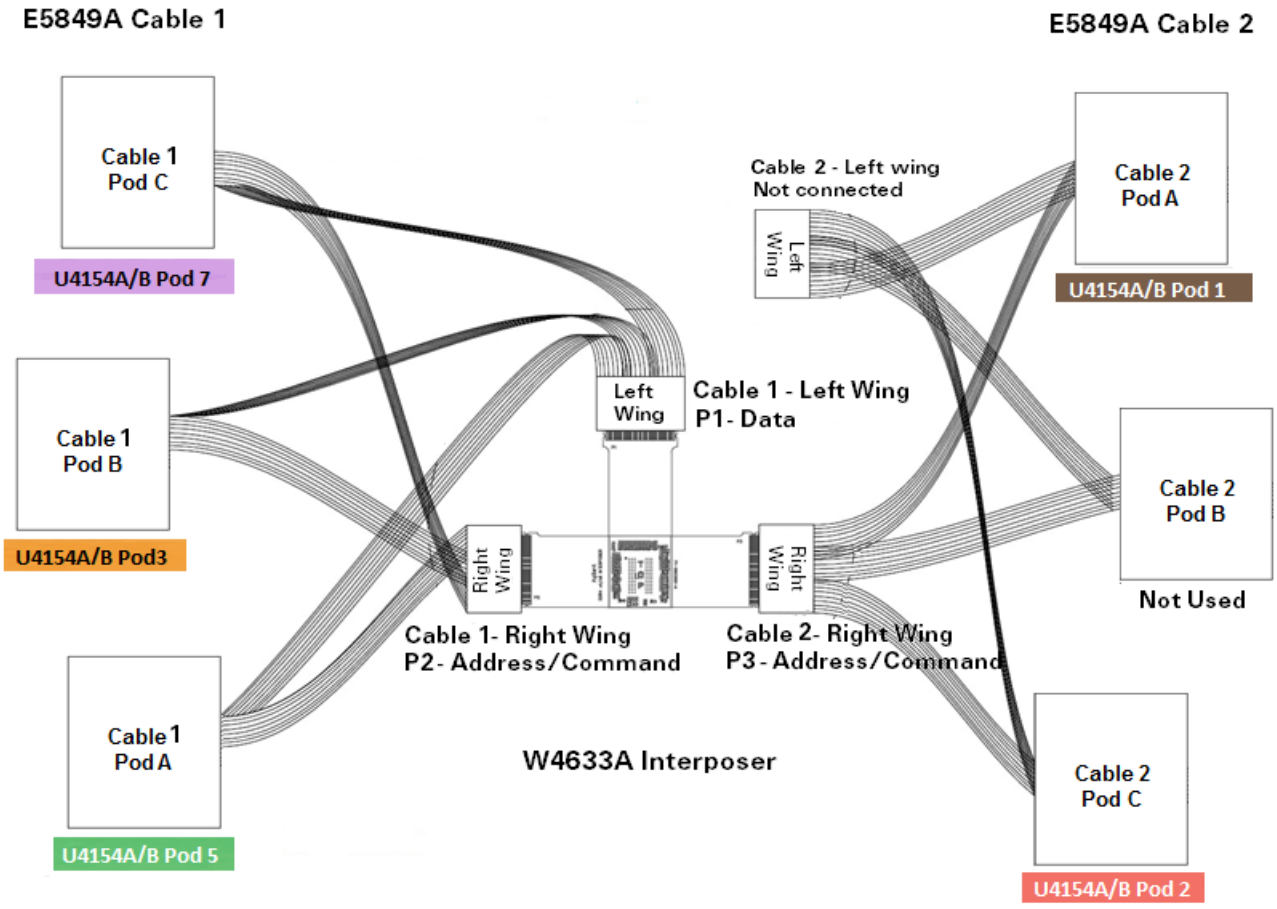


Figure 31 Connections between E5849A probe cables and Logic Analyzer pods

NOTE You need four U4201A cables to make connections as per the above diagram, One U4201A cable connects E5849A Cable 2 Pod A and Pod C to Logic Analyzer. The other three U4201A cables connect E5849A Cable 1 Pod A, Pod B, and Pod C each to Logic Analyzer.

Logic Analyzer Channel Mapping

When you connect the E5849A probe cables to a U4154A Logic Analyzer as per the diagram in Figure 31, the logic analyzer channels are mapped to signals as per the table displayed below.

These signals are automatically configured when you load one of the configuration files supplied with the Keysight B4621B decoder software.

The following table lists the mapping between the Logic Analyzer channels and signals when connected to E5849A probe cables, Cable 1 and Cable 2.

Note: Clock inputs are highlighted with yellow in this table.

Table 2 Signals and Logic Analyzer Channels Mapping for the E5849A Probe Cable

LA Channel	E5849A Cable 1 Pods			LA Channel	E5849A Cable 2 Pods		
	Pod A	Pod B	Pod C		Pod A	Pod B	Pod C
0	TDQS#	A6		0			
1	A10		A2	1	A7		
2	TDQS#	WE#	DQ5	2			
3	BG0		BA0	3	A5		BG1
4	DQS#	DQ5		4			C1
5		DQ7	A4	5	BA1		A3
6	DQS#	DQ7	DM#	6			
7		DQ6	PAR	7	ALERT#		CS#
8	ACT#	DQ6	DM#	8	A1		
9	DQ0	DQ2	A0	9			CAS#
10	C0	DQ2	DQ1	10	A13		
11	DQ0	DQS	A8	11			A12
12	ODT	DQS	DQ3	12	A9		
13	DQ4		DQ1	13			
14	C2		A11	14	A17		RAS#
15	DQ4		DQ3	15			
CLK		CKE	RST#	CLK	CK		
CLK#		PULLDN		CLK#	CK#		
LA Channel	Pod 5	Pod 3	Pod 7	LA Channel	Pod 1		Pod 2
	U4154A/B Logic Analyzer Pods				U4154A/B Logic Analyzer Pods		

Signals not probed by the Logic Analyzer

The following signals are omitted from the Logic Analyzer connections for the W4633A interposer.

Interposer	Signal Name
W4633A	VREFCA, TEN, ZQ

5 Setting up the W4631A Interposer

W4631A Interposer Setup - Overview

1. Solder the riser, interposer, sockets, and memory components. (See page 65)
2. Connect the interposer flex wings to E5849A probe cables. (See page 69)
3. Connect the E5849A probe cables to a U4154A/B Logic Analyzer module's pods via U4201A logic analyzer cables. (See page 73)

CAUTION Use ESD precautions. Electrostatic discharge can damage components on your board or in the interposer. Use a grounded wrist strap and other ESD control measures as appropriate.

NOTE Do not open the vacuum sealed packs of the W4631A interposer until you are ready to install the interposer. Discard these packs once the package is opened.

CAUTION The balls on the bottom side of the Riser or Interposer can be easily damaged. Care must be taken handling the Interposer. If the balls become deformed due to handling, these may not interface the connector as intended.

Mounting a W4631A Interposer on a PC Board using Riser and/or Sockets

You can mount a W4631A interposer on a PC board using:

- either the DDR4 riser shipped with the interposer,
- or the HSIO Technologies Grypper Socket Model 96GRY7.5x13.1-0.80 (Part # 105526-0015)
- or both the riser and sockets.

Using at least one of the two components - sockets or a riser is however, mandatory for the mounting procedure.

You may use both sockets as well as a riser to allow for height restrictions on the PC Board and/or be able to swap various DDR memory devices in the stack up. The different combinations of components yield varying measurement results.

One of the possible combinations of these stacked up components is illustrated in the following figure. The mounting procedure for socket and riser is explained in the topic that follows.

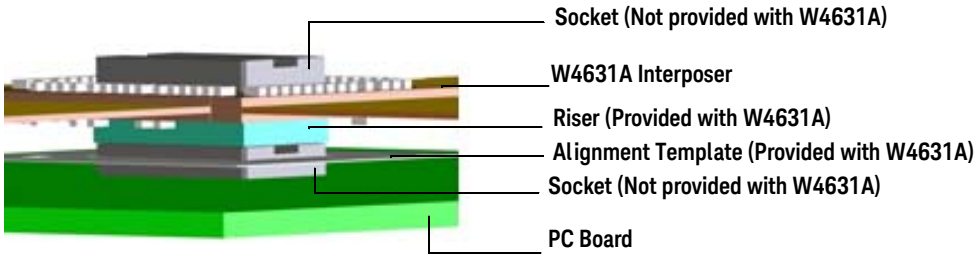


Figure 32 PC board, riser, optional Grypper sockets, and interposer stack up

After completing the mounting procedure, the desired DRAM is soldered to the top side of the interposer.

NOTE A maximum of 12.5 mm x 19 mm DDR4 DRAM package can fit on top of the W4631A interposer without an additional riser or a socket mounted between the top of the interposer and DRAM.

Before Starting the Mounting Procedure

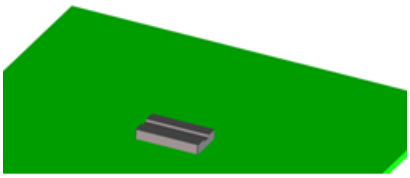
It is recommended that you:

- Review the Insertion and Removal Guide and other specifications mentioned for the socket on the HSIO Technologies website.
- Read the interposer and riser soldering guidelines and fabrication notes on page 29.
- Ensure that neither the socket nor the mating part has any debris that could short or mechanically prevent the parts from completely seating properly. Examine the part and socket under a microscope and look for bits of solder that may have dislodged from the balls on a prior installation. Also, on the part with balls, the solder can be “wiped” by the Socket contacts and pile up at the base of the balls. This could result in either a short or can prevent the part and Socket from fully mating. Use a soft brush and air to remove any debris. Solder piled up at the base of the balls may require more intricate cleaning or removal procedures.

To mount the W4631A interposer on a PC board

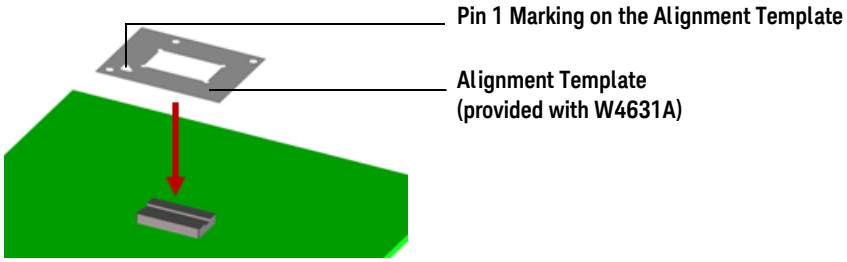
1 Solder the socket to the top and the riser to the bottom of the W4631A interposer as per the soldering guidelines given on page 29. You may opt not to use a socket or a riser while mounting. If you opt not to use the riser, it will be difficult to determine the alignment of interposer and socket on PC board visually in the next steps.

2 Install a socket on the PC board.



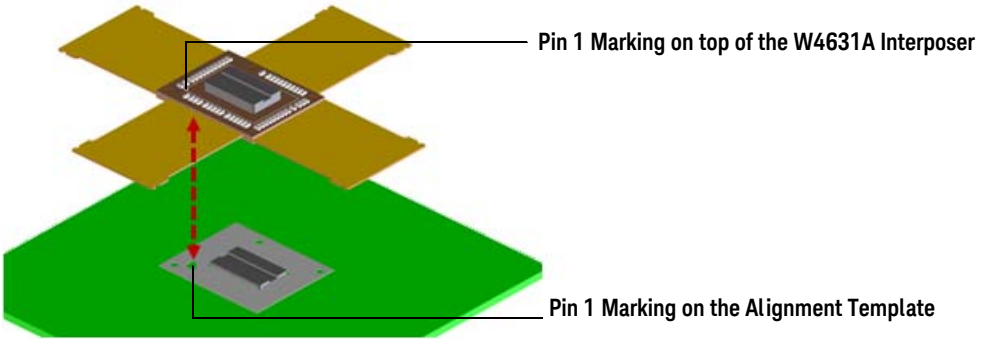
3 Install an Alignment Template on top of the socket that you installed in the previous step. When using a socket on the PC board, mounting the W4631A Interposer is aided by the use of an Alignment Template. This template is provided as a kit of six templates with the W4631A interposer. If required, you can also order this template kit as a replacement part W4631-60001.

NOTE While installing the alignment template, ensure that the alignment template is oriented correctly to align its Pin 1 with the socket's Pin 1. Pin 1 is clearly identified with a marking on the alignment template as shown in the figure below.

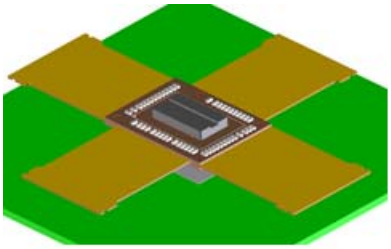


4 Orient the W4631A interposer set over the socket and alignment template that you installed in the previous step. Ensure that the interposer is oriented correctly to align its Pin 1 with the alignment template's Pin 1 as displayed in the figure below.

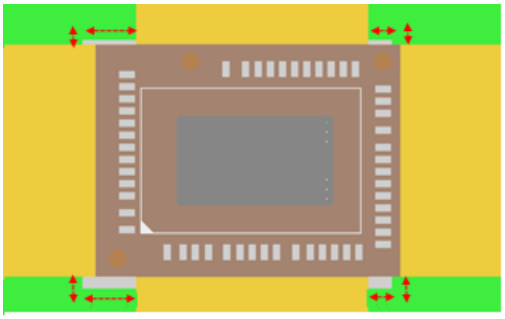
The interposer set, in the figure below, has a riser installed at its bottom and a socket installed at the top.



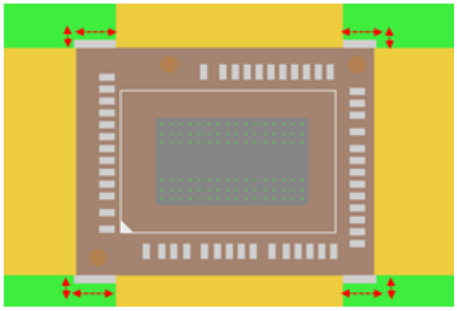
5 While keeping this orientation, gently lower the Interposer set towards the socket on the PC board so that the interposer just touches the socket.



6 Observe and correct the alignment of the Interposer with the Alignment Template so that the interposer is positioned centered over the socket on the PC board. For the alignment to be correct, make sure that the corners and edges of the interposer are aligned with the corners and edges of the alignment template keeping the same amount of overlaps on the four corners.



Interposer and Alignment Template NOT Aligned

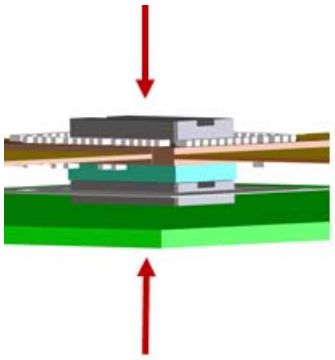


Aligned Interposer and Alignment Template

7 You can apply a small amount of finger pressure to the socket and move the Interposer around very slightly so that the balls on the bottom find the correct location over the socket and allow the assembly to be pressed into the socket on the PC board.

8 While maintaining finger pressure on top of interposer, place your index finger on the bottom of the PC board, directly under the socket and your thumb on the top of the interposer. If possible, try to observe under the Interposer to see if the riser is centered on the socket prior to pressing the Interposer into the socket. Care must be taken to NOT flex the board while pressing these components together.

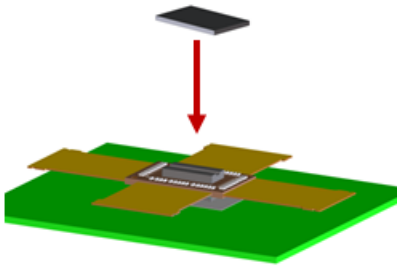
9 When you are sure of the alignment, squeeze the interposer into the socket. It should “click” into position. Move your fingers to each end of the top socket and pinch to make sure the Interposer is fully seated in the socket on the PC board. As stated in the HSIO Socket Installation guide, it may require considerable force to seat the Interposer in the socket.



NOTE If the PC board area is too large to allow your fingers to reach from the edge of the board to the socket location, then you will need to provide support under the board to apply pressure on the top. Care must be taken to NOT flex the board.

10 Finally, install the memory device to the socket on the top of the interposer. While doing so, be careful not to unseat the interposer from its socket. Support the PC board by applying finger pressure to its bottom while pressing the memory into the socket. Care must be taken to NOT flex the board while pressing these components together.

Though it is not recommended, you may install the memory device to the interposer before installing the interposer to the PC board. However, in such a situation, do NOT press the memory into the interposer socket with the balls on the bottom of the Interposer sitting on a flat, hard surface. This could deform the balls on the bottom of the Interposer.To avoid this, support the interposer balls with finger pressure while squeezing the memory into the socket.



Connecting the W4631A Interposer to E5849A Probe Cables

After soldering the components or installing with Grypper socket(s), you can start connecting the W4631A interposer to the E5849A probe cables.

CAUTION

When using a socket at the bottom of interposer, ensure that:

- While attaching the probe cables to the interposer, apply finger pressure to the top of the interposer so as not to dislodge the interposer from the socket on the PC board.

Please handle the interposer with care and ensure that the wings on the W4631A interposer are properly latched to the ZIF connectors on the E5849A probe cables.

E5849A cables ship with labels unattached. Use the sheet of labels included with the E5949A to label one as "*Cable 1*" and a second as "*Cable 2*".

The following diagram illustrates how the W4631A interposer and E5849A cables have to be connected. As illustrated in the diagram:

- Two E5849A cables, *Cable 1* and *Cable 2* are used for a single W4631A interposer.
- The left and right wings of *Cable 1* connect to **J1-Data** and **J2-Address/Data** wings respectively of the interposer.
- The left and right wings of *Cable 2* connect to **J3-Address/Command** and **J4-Address/Data** wings respectively of the interposer.

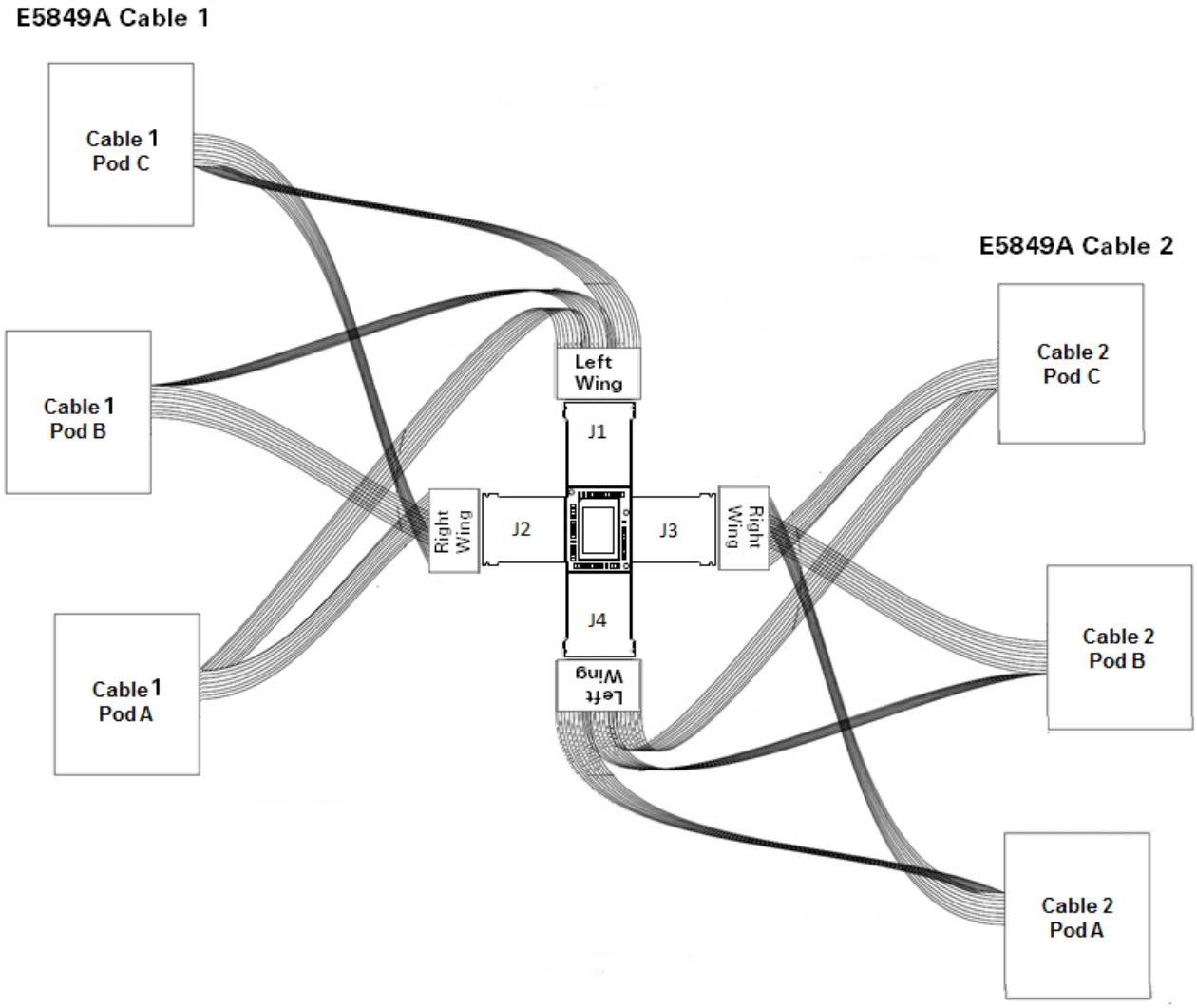


Figure 33 W4631A Interposer and E5849A Cable Connections

ZIF connectors on the E5849A cable connect to the bottom side of the flex wings on the W4631A interposer. ZIF doors close on the ground side of the flex wings. The following picture displays a W4631A interposer with E5849A ZIF connectors attached to its flex wings.

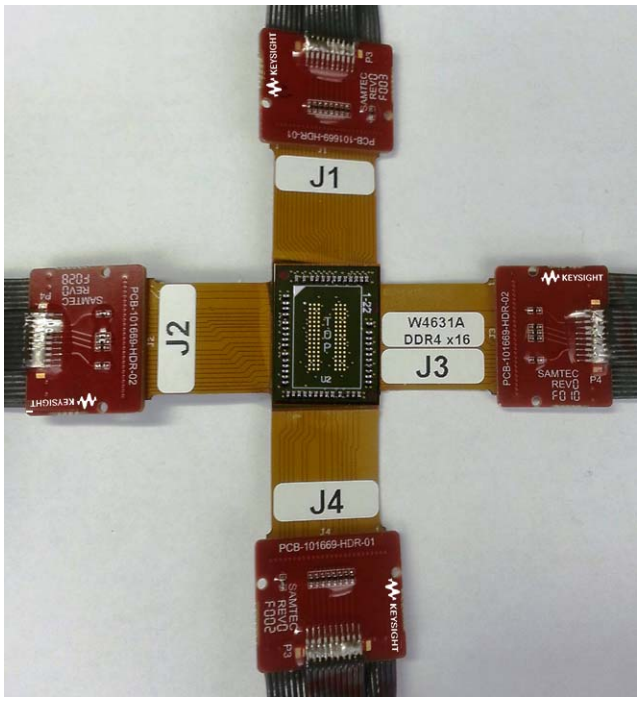


Figure 34 W4631A interposer attached to E5849A ZIF connectors

To attach an E5849A ZIF connector to a flex wing of the W4631A interposer, perform the following three steps.

1 Angle the flex wing of the interposer into an E5849A ZIF connector. GND towards door closure.
2 Align the E5849A ZIF connector tabs with interposer's wing notches.
3 Shut the ZIF door.

W4631A Interposer Wings Pinout

The following table lists the pinout of the four wings of a W4631A interposer.

In the table below:

- Clock inputs are highlighted with yellow.
- Signals beginning with an "X" are unused signals.
- Signals appended with _1 and _2 are double-probed signal pairs.
- DQS strobes are only single probed, but both polarities are probed.

Table 3 W4631A Interposer Wings Pinout

Pin	W4631A Interposer Wings			
	J1- DATA	J2 - ADDRESS/DATA	J3 - ADDRESS/COMMAND	J4 -ADDRESS/DATA
2	DQU6_1	A11	X7	X22
4	DQU6_2	A8	X8	X23
6	DQU0_1	A0	X9	X24
8	DQU0_2	BA0	X10	X25
10	DQU2_1	BG0	X11	X26
12	DQU2_2	DQL6_1	X12	A12
14	DQL3_1	DQL6_2	DMU_1	A13
16	DQL3_2	DQL2_1	X14	A9
18	DQL1_1	DQL2_2	X15	DQL7_1
20	DQL1_2	CKE	X16	DQL7_2
22	DML_1	X1	DMU_2	X20
24	DML_2	PULLDN	X18	ACT_n
26	DQU7_1	RST_N	X19	A5
28	DQU7_2	DQL4_1	ODT	A1
30	DQSU_c	DQL4_2	CS_n	X2
32	DQSU_t	DQL0_1	A16	X3
34	DQL5_1	DQL0_2	A15	A4
36	DQL5_2	DQSL_t	BA1	A10
38	DQU1_1	DQSL_c	A3	X27
40	DQU1_2	X4	ALERT_n	A2
42	DQU3_1	X5	CK_t	A14
44	DQU3_2	X6	CK_c	A6
46	DQU5_1	DQU4_1	A7	PAR
48	DQU5_2	DQU4_2	X21	X28
50	GND	GND	GND	GND
ODD	GND	GND	GND	GND
Pin	**E5849A Cable 1 Left Wing Connector**	**E5849A Cable 1 Right Wing Connector**	**E5849A Cable 2 Right Wing Connector**	**E5849A Cable 2 Left Wing Connector**

Connecting the E5849A Probe Cables to a Logic Analyzer

In a W4631A interposer setup, you make connections between an E5849A probe cable and a U4154A/B logic analyzer module by:

- First connecting the E5849A probe cable to a U4201A cable.
- Then connecting this U4201A cable to the relevant Logic Analyzer pod on the front panel of the U4154A/B module.

The following figure displays the relevant U4154A/B Logic Analyzer pods that you need to use to connect the right and left wings of the two E5849A probe cables used in a W4631A interposer setup (for data rates under 2.5Gbs).

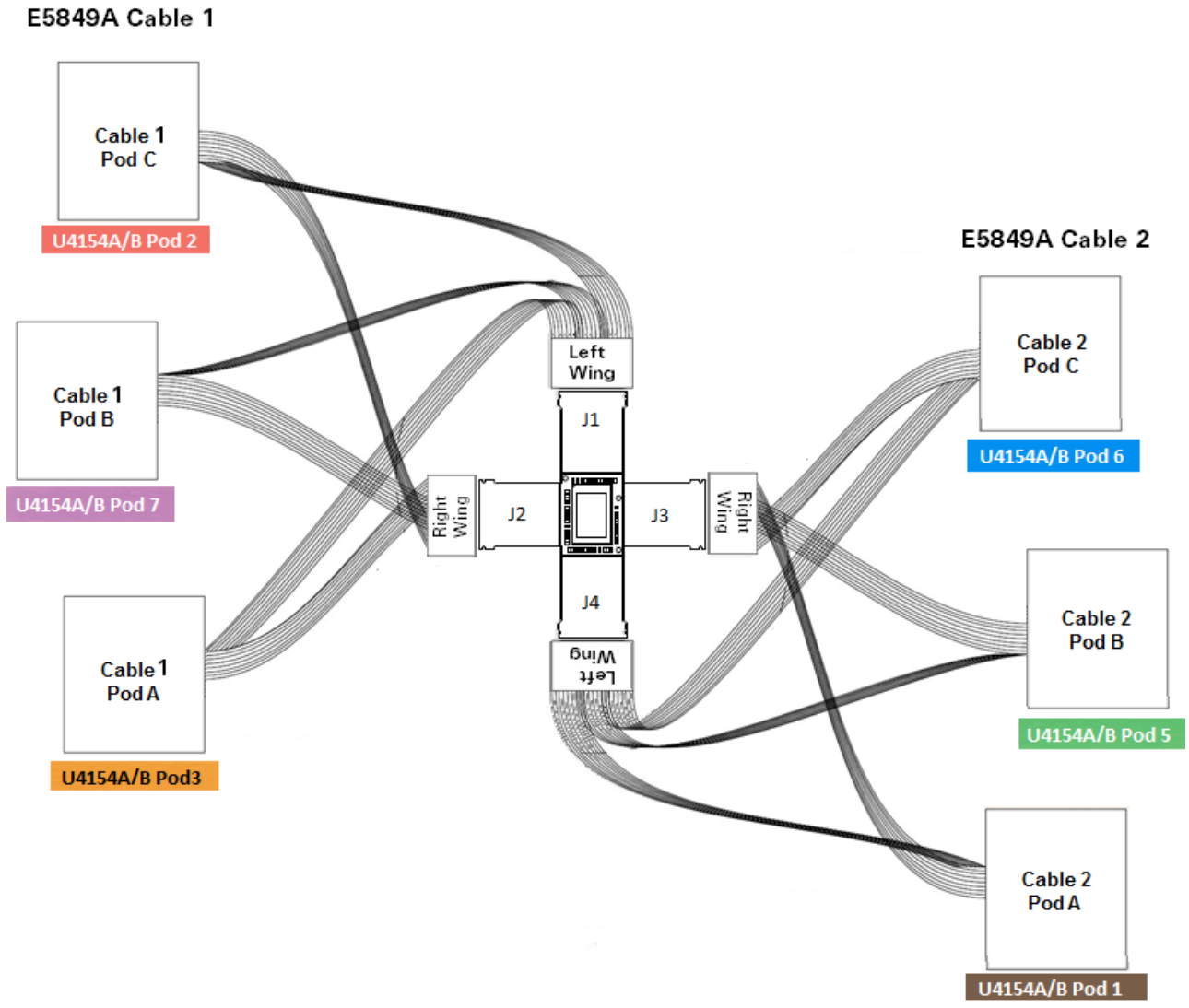


Figure 35 Connections between W4631A with two E5849A and pods of a single U4154A/B logic analyzer (for data rates under 2.5Gbs)

E5849A Cables to Logic Analyzer Pods Connection Mapping (for < 2.5 Gb/s Data Rates)

This default configuration uses two E5849A cables and a single U4154A/B module.

Logic Analyzer Pods	E5849A Cable Pods
Slot 1 Pod 1	Cable 2 Pod A
Slot 1 Pod 2	Cable 1 Pod C
Slot 1 Pod 3	Cable 1 Pod A
Slot 1 Pod 5	Cable 2 Pod B
Slot 1 Pod 7	Cable 1 Pod B
Slot 1 Pod 6	Cable 2 Pod C

DDR4 x16 ZIF Cable to Logic Analyzer Pods Connection Mapping (for < and > 2.5 Gb/s Data Rates)

This default configuration uses a single DDR4 x16 ZIF cable and a single U4154A/B module.

Logic Analyzer Pods	DDR4 x16 ZIF Cable Pods
Slot 1 Pod 1	Pod D
Slot 1 Pod 2	Pod E
Slot 1 Pod 3	Pod B
Slot 1 Pod 5	Pod A
Slot 1 Pod 7	Pod C

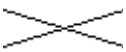
Logic Analyzer Channel Mapping

When you connect the E5849A probe cables to a U4154A/B Logic Analyzer as per the diagram in Figure 35, the logic analyzer channels are mapped to signals as per the mapping tables Table 4 and Table 5 displayed below. Table 4 provides mapping for a single-probed test setup for up to 2,500 Mbps operation. Table 5 provides mapping for a double probing test setup for above 2,500 Mbps operations.

These signals are automatically configured when you load one of the configuration files supplied with the Keysight B4621B decoder software.

The following tables list the mapping between the Logic Analyzer channels and signals when connected to E5849A probe cables, Cable 1 and Cable 2.

In the tables below:

- Clock inputs are highlighted with yellow.
- Signals beginning with an "X" are unused signals.
- Signals appended with _1 and _2 are double-probed signal pairs.
- Table cells marked with  indicate pins that are not accessible with E5849A cables.

Logic Analyzer Channel Mapping For a single-probed test setup for up to 2,500 Mbps operation

Table 4 Signals and Logic Analyzer Channels Mapping for the E5849A Probe Cable - Low Speed Connection Scheme

LA Channel	E5849A Cable 1 Pods		
	Pod A	Pod B	Pod C
0	DQU2_1	DQL6_2	
1	DQL0_2	X1	A11
2	DQU2_2	DQSL_t	DQU5_2
3	DQL0_1		DQL2_1
4	DQL3_2	DQU5_1	A0
5	DQL4_1	DQSU_t	DQL2_2
6	DQL3_1	DQSU_c	DQU3_2
7	DQL4_2	DQU7_2	A8
8	DQSL_c	DQU7_1	DQU3_1
9	DQU0_1	DML_2	BA0
10	X4	DML_1	DQU1_1
11	DQU0_2	DQL1_2	DQL6_1
12	DQU4_2	DQL1_1	DQL5_1
13	DQU6_2		DQU1_2
14	DQU4_1		BG0
15	DQU6_1		DQL5_2
CLK	X5	RST_N	CKE
CLK#	X6	PULLDN	
LA Channel	Pod 3	Pod 7	Pod 2
	U4154A/B Logic Analyzer Pods		

LA Channel	E5849A Cable 2 Pods		
	Pod A	Pod B	Pod C
0	X26	DMU_1	
1	A15	DMU_2	X7
2	A12	BA1	X28
3	A16		X14
4	A9	PAR	X9
5	ODT	X3	X15
6	A13	X2	A6
7	CS_n	A1	X8
8	A3	A5	A14
9	X24	ACT_n	X10
10	ALERT_n	X20	X27
11	X25	DQL7_2	X12
12	X21	DQL7_1	A4
13	X23		A2
14	A7		X11
15	X22		A10
CLK	CK_t	X19	X16
CLK#	CK_c	X18	
LA Channel	Pod 1	Pod 5	Pod 6
	U4154A/B Logic Analyzer Pods		

Logic Analyzer Channel Mapping For a Double Probing Test Setup for above 2,500 Mbps Operations

For operations above 2,500 Mbps, or when different read and write thresholds are required, the High Speed connections must be used.

In such situations, two U4154A/B modules are required for full probing of a single DDR4 x16 DRAM above 2,500 Mbps. This Logic Analyzer Configuration uses dual sample mode as well as double probing to capture rising and falling edges of all dual data rate signals while maintaining separate read and write thresholds.

Table 5 Signals and Logic Analyzer Channels Mapping for the E5849A Probe Cable - High Speed Connection Scheme

LA Channel	E5849A Cable 1 Pods		
	Pod A	Pod B	Pod C
0	DQU2_1	DQL6_2	
1	DQL0_2	X1	A11
2	DQU2_2	DQSL_t	DQU5_2
3	DQL0_1		DQL2_1
4	DQL3_2	DQU5_1	A0
5	DQL4_1	DQSU_t	DQL2_2
6	DQL3_1	DQSU_c	DQU3_2
7	DQL4_2	DQU7_2	A8
8	DQSL_c	DQU7_1	DQU3_1
9	DQU0_1	DML_2	BA0
10	X4	DML_1	DQU1_1
11	DQU0_2	DQL1_2	DQL6_1
12	DQU4_2	DQL1_1	DQL5_1
13	DQU6_2		DQU1_2
14	DQU4_1		BG0
15	DQU6_1		DQL5_2
CLK	X5	RST_N	CKE
CLK#	X6	PULLDN	
LA Channel	Module 1 Pod 3	Module 1 Pod 7	Module 1 Pod 2
	U4154A/B Logic Analyzer Pods		

LA Channel	E5849A Cable 2 Pods		
	Pod A	Pod B	Pod C
0	X26	DMU_1	
1	A15	DMU_2	X7
2	A12	BA1	X28
3	A16		X14
4	A9	PAR	X9
5	ODT	X3	X15
6	A13	X2	A6
7	CS_n	A1	X8
8	A3	A5	A14
9	X24	ACT_n	X10
10	ALERT_n	X20	X27
11	X25	DQL7_2	X12
12	X21	DQL7_1	A4
13	X23		A2
14	A7		X11
15	X22		A10
CLK	CK_t	X19	X16
CLK#	CK_c	X18	
LA Channel	Module 1 Pod 1	Module 2 Pod 5	Module 1 Pod 6
	U4154A/B Logic Analyzer Pods		

Signals not probed by the Logic Analyzer

The following signals are omitted from the Logic Analyzer connections for the W4631A interposer.

Signal Name	Type	Description
VREFCA	Power Supply	Reference voltage for control, command, and address pins
TEN	Input	Connectivity test mode: LOW during normal operation
ZG	Reference	ZQ calibration reference

6 Setting up the W4636A Interposer

W4636A Interposer Setup - Overview

1 Solder the interposer, socket (optional), and memory components. (See page 81)
2 Connect the interposer flex wings to an E5847A probe cable. (See page 82)
3 Connect the E5847A probe cable to a U4154A/B Logic Analyzer module's pods via U4201A logic analyzer cables. (See page 85)

CAUTION Use ESD precautions. Electrostatic discharge can damage components on your board or in the interposer. Use a grounded wrist strap and other ESD control measures as appropriate.

NOTE Do not open the vacuum sealed packs of the W4636A interposer until you are ready to install the interposer. Discard these packs once the package is opened.

Soldering the W4636A Interposer

The W4636A interposer needs to be attached to the DRAM PCB footprint on the design to be probed. The desired DRAM is soldered to the top side of the interposer. This attachment may occur in any order (i.e. first solder the interposer to the DUT, and then solder the DRAM to the interposer, or first solder the DRAM to the interposer, and then solder the DRAM+interposer assembly to the DUT). The interposer is designed to tolerate lead-free soldering temperature profiles. However, it is always recommended to apply the minimum temperature required and the minimum number of heating/cooling cycles to reduce risk of any damage to the interposer.

The stack up of these soldered components is illustrated in the following figure.

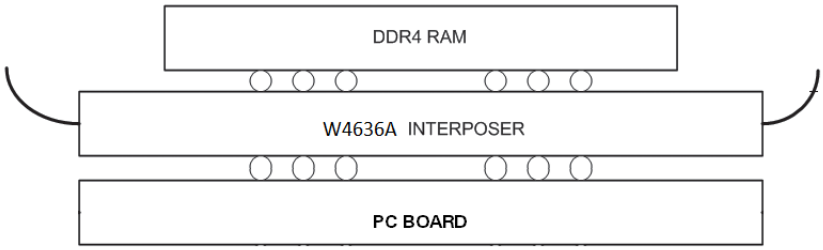


Figure 36 PC board, interposer, and DRAM stack up

NOTE A maximum of 12.5 mm x 19 mm DDR4 DRAM package can fit on top of the W4636A interposer. No additional riser or a socket is required between the top of the interposer and DRAM.

Refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

Connecting the W4636A Interposer to an E5847A Probe Cable

After soldering components, you can start connecting the W4636A interposer to the E5847A probe cable.

CAUTION

Please handle the interposer with care and ensure that the wings on the W4636A interposer are properly latched to the ZIF connectors on the E5847A probe cable.

The following diagram illustrates how the W4636A interposer and E5847A cable have to be connected. As illustrated in the diagram:

- One E5847A cable is used for a single W4636A interposer.
- The left and right wings of *the cable* connect to **P1** and **P2** wings respectively of the interposer.

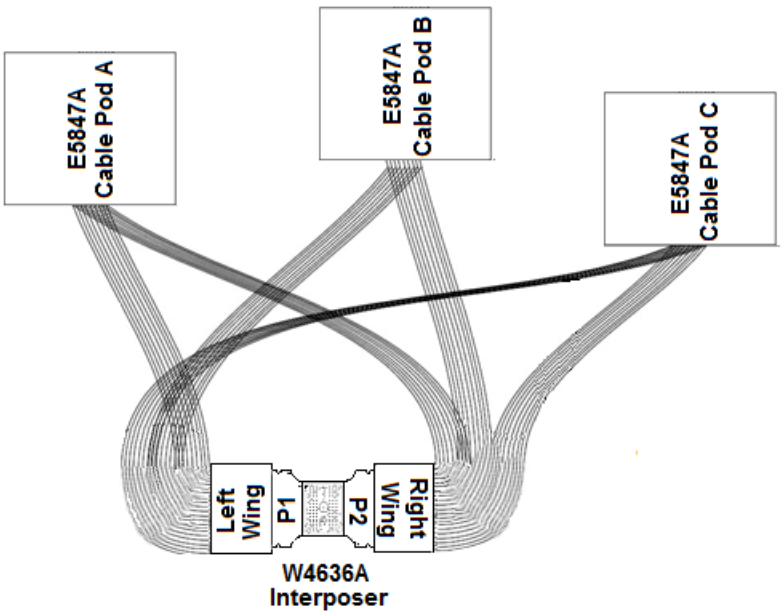


Figure 37 W4636A Interposer and E5847A Cable Connections

ZIF connector pin-outs on the E5847A cable connect to the top side of the flex wings on the W4636A interposer. ZIF doors close on the top side of the flex wings. The following picture displays a W4636A interposer with E5847A ZIF connectors attached to its flex wings.

Figure 38 W4636A interposer attached to E5847A ZIF connectors

To attach an E5847A ZIF connector to a flex wing of the W4636A interposer, perform the following three steps.

1 Angle the flex wing of the interposer into an E5847A ZIF connector. GND towards door closure.
2 Align the E5847A ZIF connector tabs with interposer's wing notches.
3 Shut the ZIF door.

W4636A Interposer Wings Pinout

The following table lists the pinout of the two wings of a W4636A interposer.

In the table below, clock inputs are highlighted with yellow.

Table 6 W4636A Interposer Wings Pinout

Pin	W4636A Interposer Wings	
	P1	P2
2	DQU0	A9
4	DQU2	A13
6	CKE	A5
8	GND	A7
10	DQU6	A1
12	DQU4	ALERT_n
14	-	BA1
16	DMU_n	A3
18	DQSL_c	A15
20	DQL0	A12
22	CS_n	RST_n
24	ODT	A16
26	A14	CK_c
28	ACT_n	CK_t
30	BG0	DQU7
32	BA0	DQU5
34	A10	DQU3
36	A4	DQU1
38	A6	DQSU_c
40	A0	-
42	A8	-
44	A11	-
46	A2	-
48	PAR	-
50	GND	GND
ODD	GND	GND
Pin	**E5847A Cable Left Wing Connector**	**E5847A Cable Right Wing Connector**

Connecting the E5847A Probe Cable to a Logic Analyzer

In a W4636A interposer setup, you make connections between an E5847A probe cable and a U4154A/B logic analyzer module by:

- First connecting the E5847A probe cable to a U4201A cable.
- Then connecting this U4201A cable to the relevant Logic Analyzer pod on the front panel of the U4154A/B module.

The following figure displays the relevant U4154A/B Logic Analyzer pods that you need to use to connect the right and left wings of a E5847A probe cable used in a W4636A interposer setup.

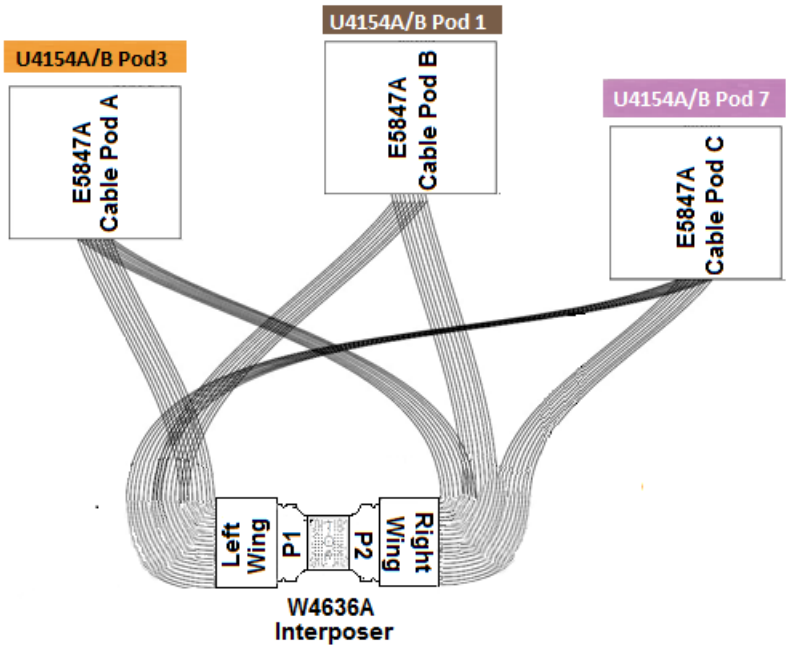


Figure 39 Connections between W4636A with a E5847A and pods of a single U4154A/B logic analyzer

U4154A/B Logic Analyzer Pods	DDR4 x16 ZIF Cable Pods
Slot 1 Pod 1	Pod B
Slot 1 Pod 3	Pod A
Slot 1 Pod 7	Pod C

Logic Analyzer Channel Mapping

When you connect the E5847A probe cable to a U4154A/B Logic Analyzer as per the diagram in Figure 39, the logic analyzer channels are mapped to signals as per the mapping table Table 7 displayed below.

These signals are automatically configured when you load one of the configuration files supplied with the Keysight B4621B decoder software.

In the table below:

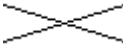
- Clock inputs are highlighted with yellow.
- Signals beginning with an "X" are unused signals.
- Table cells marked with  indicate pins that are not accessible with an E5847A cable.

Table 7 Signals and Logic Analyzer Channels Mapping for the E5847A Probe Cable

LA Channel	E5847A Cable Pods		
	Pod A	Pod B	Pod C
0	DQU0	BA1	A15
1	DQU1		A9
2	DQU2	A16	PAR
3	DQU3		A3
4	DQU4	A2	A5
5	DQU7	BA0	A12
6	DQU6	BG0	A11
7	DQU5	ACT_n	A13
8	DQSU_c	A14	A8
9		ODT	A7
10		CS_n	A6
11		DQL0	ALERT_n
12		DQSL_c	A4
13		DMU_n	A0
14			A1
15			A10
CLK	CKE	CK_t	RST_n
CLK#	GND	CK_c	
LA Channel	Pod 3	Pod 1	Pod 7
	U4154A/B Logic Analyzer Pods		

Signals not probed by the Logic Analyzer

The following signals are omitted from the Logic Analyzer connections for the W4636A interposer.

Signal Name	Type
VREFCA TEN ZQ	Control and other signals group
DQS0 DQS1 DQS1# DQ1 DQ2 DQ3 DQ4 DQ5 DQ6 DQ7 DM0	Data signal group

7 Setting up the W4643A Interposer

W4643A Interposer Setup - Overview

1 Solder the riser, interposer, and memory components. (See page 91)
2 Connect the interposer flex wings to U4208A and U4209A probe cables. (See page 92)
3 Connect the U4208A and U4209A probe cables to a U4164A Logic Analyzer module's pods. (See page 95)

CAUTION Use ESD precautions. Electrostatic discharge can damage components on your board or in the interposer. Use a grounded wrist strap and other ESD control measures as appropriate.

NOTE Do not open the vacuum sealed packs of the W4643A interposer until you are ready to install the interposer. Discard these packs once the package is opened.

Soldering the W4643A Interposer and Riser

The W4643A interposer needs to be attached to the DRAM PCB footprint on the design to be probed with either the riser soldered or an optional Grypper socket (not included with the interposer) installed in between the interposer and PC board. The desired DRAM is soldered to the top side of the interposer. The stack up of these soldered components is illustrated in the following figure.

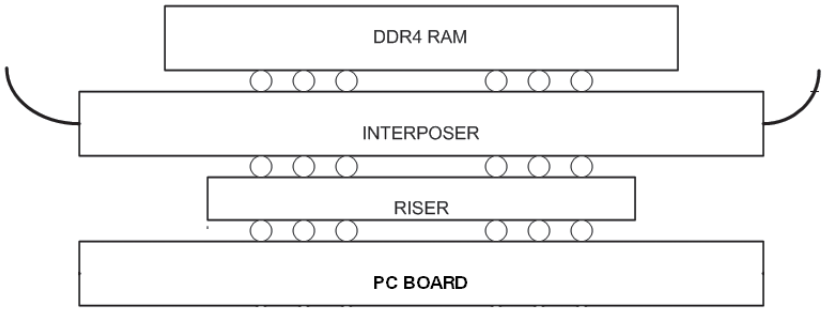


Figure 40 PC board, riser (or optional Grypper socket), interposer, and DRAM stack up

NOTE A maximum of 11 mm x 13 mm DDR4 DRAM package can fit on top of the W4643A interposer without an additional riser or a socket on the top of the interposer and under DRAM.

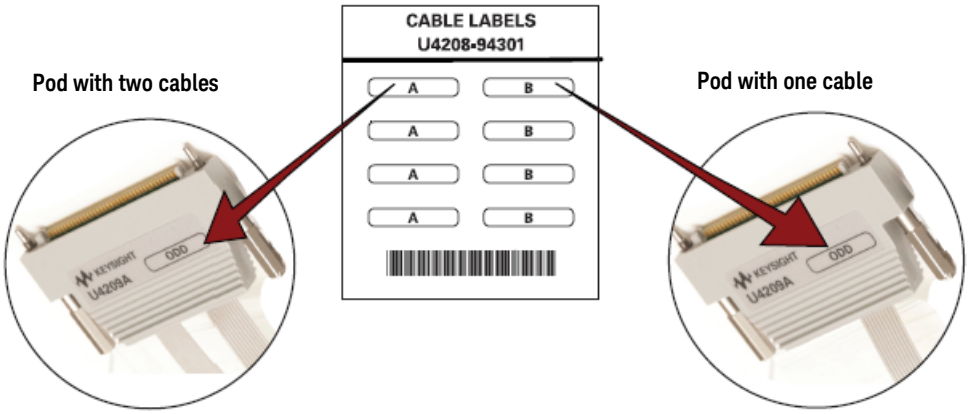
Refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

Connecting the W4643A Interposer to U4208A and U4209A Probe Cables

After soldering the components or installing with a Grypper socket, you can start connecting the W4643A interposer to the U4208A and U4209A probe cables.

NOTE **Please handle the interposer with care and ensure that the wings on the W4643A interposer are properly latched to the ZIF connectors on the U4208A and U4209A probe cables.**

U4208A and U4209A cables ship with pod labels unattached. Use the sheet of labels included with the cable shipment to label pods as follows.



As illustrated in the diagram below, you need to connect:

- the U4208A probe cable to the left wing of the interposer.
- the U4209A probe cable to the right wing of the interposer.

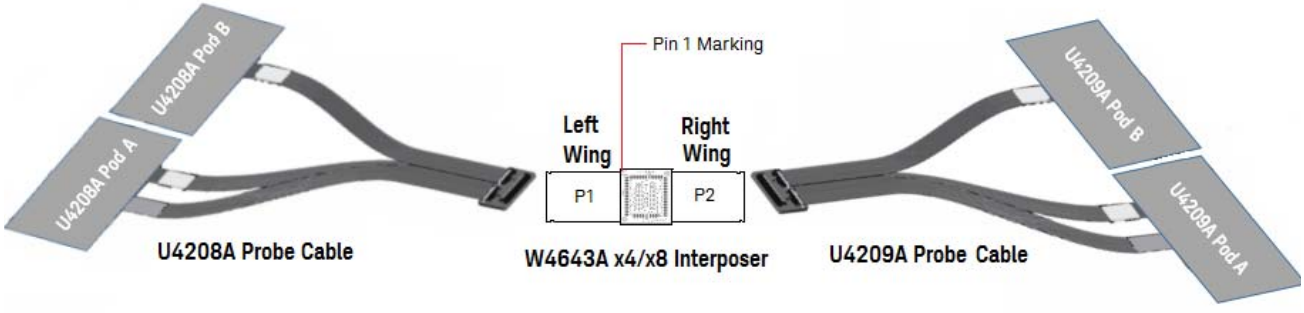


Figure 41 W4643A Interposer and U4208A / U4209A Probe Cable Connections

ZIF connectors on the U4208A/U4209A cable connect to the top side of the flex wings on the W4643A interposer. ZIF doors open on the top of the flex wings. The following picture displays a W4643A interposer with U4208A and U4209A ZIF connectors attached to its flex wings.

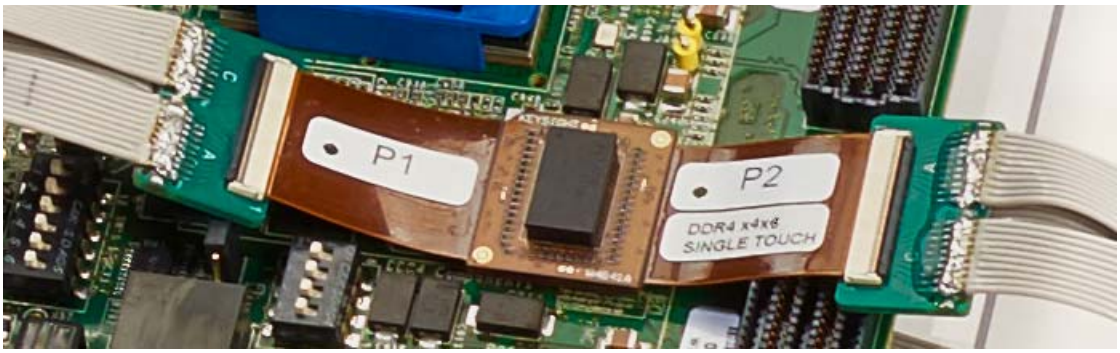


Figure 42 W4643A interposer attached to U4208A and U4209A ZIF connectors

To attach a U4208A or a U4209A ZIF connector to a flex wing of the W4643A interposer, perform the following three steps.

1 Angle the flex wing of the interposer into the probe cable's ZIF connector.

2 Align the probe cable's ZIF connector tabs with interposer's wing notches.

3 Shut the ZIF door.

W4643A Interposer Wings Pinout

The following table lists the pinout of the two wings of a W4643A interposer. The table includes the signals being probed when using the interposer in a dual sampling mode or a quad sampling mode (supported by the U4164A logic analyzer module).

In this table,

- Clock/Qualifier inputs are highlighted with yellow
- Signals that can be quad-sampled are highlighted with green
- Single/dual sampled signals are highlighted with blue
- Table cells marked with indicate pins that are not accessible.

Table 8 W4643A Interposer Wings Pinout

Pin	W4643A Interposer Wings	
	Right Wing	Left Wing
2		A0
4		PAR
6		A2
8	DBI_n	A11
10		
12		
14	DQ1	
16	DQ3	A8
18	DQ7	A6
Pin	U4209A	U4208A

Pin	W4643A Interposer Wings	
	Right Wing	Left Wing
20	DQ5	BA0
22		A4
24	CS_n	BG0
26	C1	A10
28	ALERT_n	A14
30	CK_c	CKE
32	CK_t	GND
34	A16	C0
36	A12	ACT_n
38	BG1	C2
40	BA1	ODT
42	A15	DQ6
44	A3	DQ4
46	A5	
48	A7	DQ0
50		RST_n
52		GND
54	A13	DQS_t
56	A1	DQS_c
58	A17	DQ2
60	A9	TDQS_c
Pin	U4209A	U4208A

Connecting the U4208A and U4209A Probe Cables to a U4164A Logic Analyzer

In a W4643A interposer setup, you connect the U4208A and U4209A probe cable pods to U4164A logic analyzer pods as per the mapping shown in the table below.

Probe Cable Pods	U4164A Logic Analyzer Pods
U4209A Cable Pods	
Pod A	Pod 1 (signals are dual-sampled on this pod)
Pod B	Pod 5 (signals can be quad-sampled on this pod)
U4208A Cable Pods	
Pod A	Pod 3 (signals are dual-sampled on this pod)
Pod B	Pod 7 (signals can be quad-sampled on this pod)

NOTE

In a dual-sampled setup, the U4164A logic analyzer samples data twice per clock edge. Two thresholds are used with one sample taken per threshold. For DDR systems running less than 2.5GHz, the dual sampling allows separate thresholds and separate sample positions to be specified for DDR Reads and Writes.

In a quad-sampled setup, four samples are taken per clock edge. Two thresholds are used with two samples taken per threshold.

The mapping of the U4208A and U4209A probe cable pods and logic analyzer pods is also illustrated with the help of the following diagram.

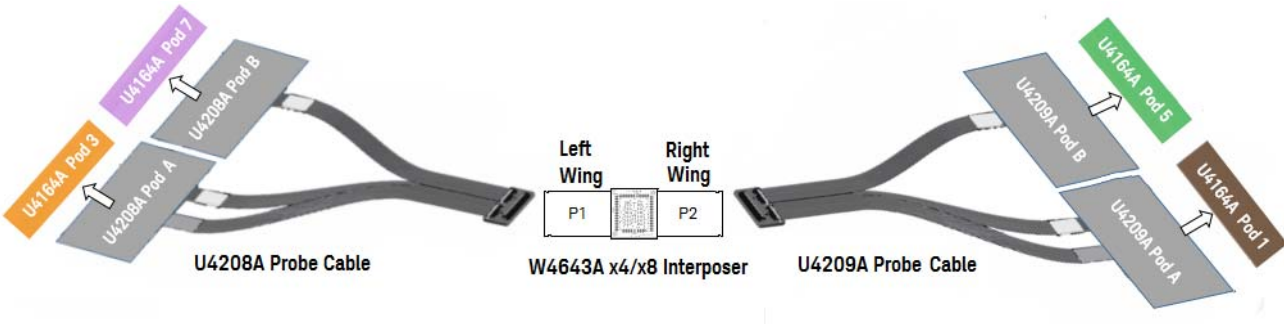


Figure 43 Connections between U4208A and U4209A probe cables and Logic Analyzer pods

Logic Analyzer Channels to Signals Mapping

When you connect the U4208A and U4209A probe cables to a U4164A Logic Analyzer as per the connection diagram in Figure 43, the logic analyzer channels are mapped to DDR4 signals as per the table displayed below.

These signals are automatically configured when you load one of the configuration files supplied with the Keysight B4661A decoder software.

Notes:

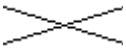
- Clock inputs for each logic analyzer pod are highlighted with yellow in this table.
- Table cells marked with  indicate logic analyzer channels that are not accessible.

Table 9 Signals and Logic Analyzer Channels Mapping when using the W4643A Interposer

Logic Analyzer Pod and its Channels		Signals on U4208A probe cable Pod A
Pod 3 (Signals can be dual-sampled on this pod)	0	A0
	1	PAR
	2	A2
	3	A11
	4	
	5	A8
	6	A6
	7	BA0
	8	A4
	9	BG0
	10	A10
	11	A14
	12	C0
	13	ACT_n
	14	C2
	15	ODT
	CLK	CKE
	CLK#	GND

Logic Analyzer Pod and its Channels		Signals on U4208A probe cable Pod B
Pod 7 (Signals can be quad-sampled on this pod)	0	DQ6
	1	
	2	DQ4
	3	
	4	
	5	
	6	DQ0
	7	
	8	DQS_t
	9	
	10	DQS_c
	11	
	12	DQ2
	13	
	14	TDQS_c
	15	
	CLK	RST_n
	CLK#	GND

Logic Analyzer Pod and its Channels		Signals on U4209A probe cable Pod A
Pod 1 (Signals can be dual-sampled on this pod)	0	A9
	1	A17
	2	A1
	3	A13
	4	A7
	5	A5
	6	A3
	7	A15
	8	BA1
	9	BG1
	10	A12
	11	A16
	12	ALERT_n
	13	C1
	14	CS_n
	15	
	CLK	CK_t
	CLK#	CK_c

Logic Analyzer Pod and its Channels		Signals on U4209A probe cable Pod B
Pod 5 (Signals can be quad-sampled on this pod)	0	DQ5
	1	
	2	DQ7
	3	
	4	DQ3
	5	
	6	DQ1
	7	
	8	DBI_n
	9	
	10	
	11	
	12	
	13	
	14	
	15	
	CLK	
	CLK#	

Signals not probed by the Logic Analyzer

The following signals are omitted from the Logic Analyzer connections for the W4643A interposer.

Interposer	Signal Name
W4643A	VREFCA, TEN, ZQ, DQSL_c

8 Setting up the W4641A Interposer

W4641A Interposer Setup - Overview

1 Solder the interposer, socket (optional), and memory components. (See page 101)
2 Connect the interposer flex wings to U4208A and U4209A probe cables. (See page 102)
3 Connect the U4208A and U4209A probe cables to a U4164A Logic Analyzer module's pods. (See page 105)

CAUTION Use ESD precautions. Electrostatic discharge can damage components on your board or in the interposer. Use a grounded wrist strap and other ESD control measures as appropriate.

NOTE Do not open the vacuum sealed packs of the W4641A interposer until you are ready to install the interposer. Discard these packs once the package is opened.

Soldering the W4641A Interposer

The W4641A interposer needs to be attached to the DRAM PCB footprint on the design to be probed. The desired DRAM is soldered to the top side of the interposer. This attachment may occur in any order (i.e. first solder the interposer to the DUT, and then solder the DRAM to the interposer, or first solder the DRAM to the interposer, and then solder the DRAM+interposer assembly to the DUT). The interposer is designed to tolerate lead-free soldering temperature profiles. However, it is always recommended to apply the minimum temperature required and the minimum number of heating/cooling cycles to reduce risk of any damage to the interposer.

The stack up of these soldered components is illustrated in the following figure.

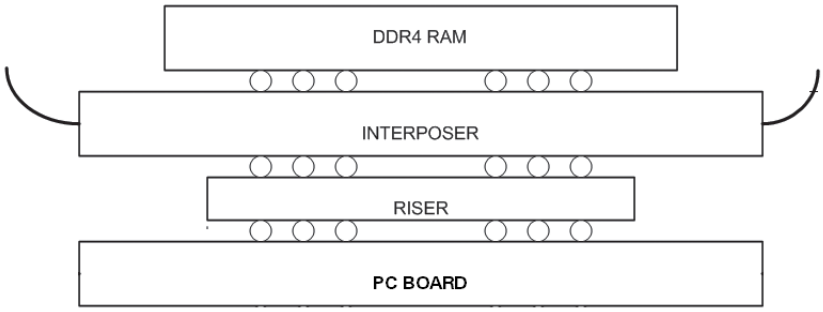


Figure 44 PC board, riser, interposer, and DRAM stack up

NOTE A maximum of 10 mm x 14 mm DDR4 DRAM package can fit on top of the W4641A interposer.

Refer to the chapter "W4630-Series and W4640-Series Interposers and Riser Soldering Guidelines" on page 47.

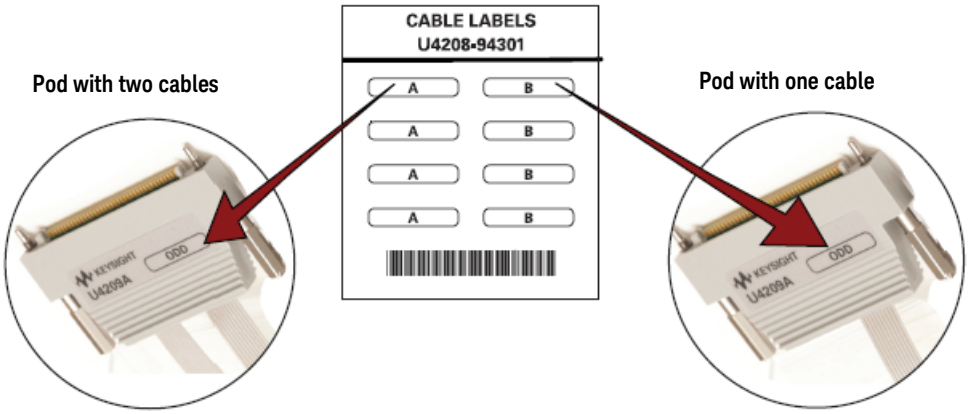
Connecting the W4641A Interposer to U4208A and U4209A Probe Cables

After soldering components, you can start connecting the W4641A interposer to the U4208A and U4209A probe cables.

CAUTION

Please handle the interposer with care and ensure that the wings on the W4641A interposer are properly latched to the ZIF connectors on the U4208A and U4209A probe cables.

U4208A and U4209A cables ship with pod labels unattached. Use the sheet of labels included with the cable shipment to label pods as follows.



As illustrated in the diagram below, you need to connect:

- the U4208A probe cable to the left wing of the interposer.
- the U4209A probe cable to the right wing of the interposer.

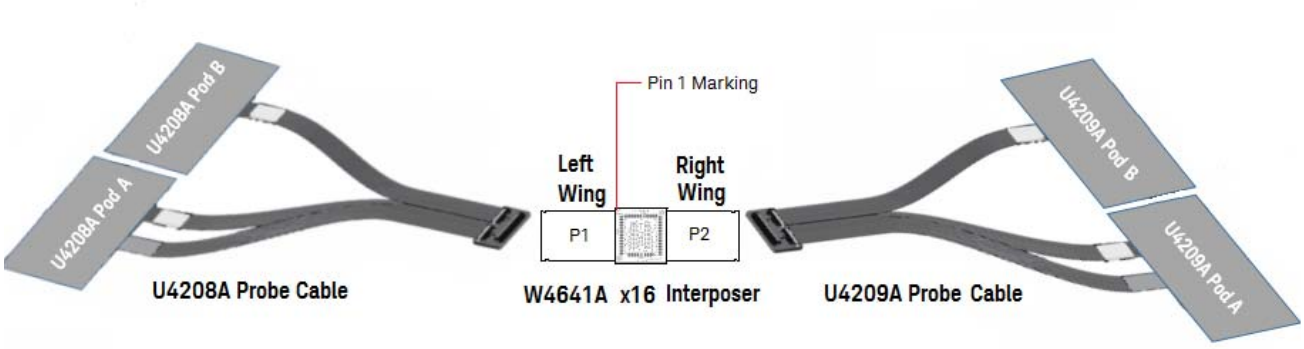


Figure 45 W4641A Interposer and U4208A / U4209A Probe Cable Connections

ZIF connectors on the U4208A/U4209A cable connect to the top side of the flex wings on the W4641A interposer. ZIF doors open on the top of the flex wings. The following picture displays a W4641A interposer with U4208A and U4209A ZIF connectors attached to its flex wings.

Figure 46 W4641A interposer attached to U4208A and U4209A ZIF connectors

To attach a U4208A or a U4209A ZIF connector to a flex wing of the W4641A interposer, perform the following three steps.

1 Angle the flex wing of the interposer into the probe cable's ZIF connector.
2 Align the probe cable's ZIF connector tabs with interposer's wing notches.
3 Shut the ZIF door.

W4641A Interposer Wings Pinout

The following table lists the pinout of the two wings of a W4641A interposer. The table includes the signals being probed when using the interposer in a dual sampling mode or a quad sampling mode (supported by the U4164A logic analyzer module).

In this table,

- Clock/Qualifier inputs are highlighted with yellow
- Signals that can be quad-sampled are highlighted with green
- Dual-sampled signals are highlighted with blue
- Table cells marked with indicate pins that are not accessible.

Table 10 W4641A Interposer Wings Pinout

Pin	W4641A Interposer Wings	
	Right Wing	Left Wing
2	DQL1	A4
4	DQU1	A2
6	DQU3	A0
8	DQU5	A10
10	DQSU_c	
12	DQSU_t	
14	DQU7	PAR
16	DQL3	A11
Pin	U4209A	U4208A

Pin	W4641A Interposer Wings	
	Right Wing	Left Wing
18	DQL5	A8
20	DQL7	A6
22	DML_n	BA0
24	DML_n	BG0
26	CS_n	ACT_n
28	A16	ODT
30	CK_c	CKE
32	CK_t	GND
34		A14
36	A15	DQSL_t
38	BA1	DMU_n
40	ALERT_n	DMU_n
42	A5	DQL6
44	A7	DQL2
46	A13	DQL4
48	A12	DQU4
50		RST_n
52		GND
54	A1	DQU6
56	A9	DQU0
58		DQU2
60	A3	DQL0
Pin	U4209A	U4208A

Connecting the U4208A and U4209A Probe Cables to a U4164A Logic Analyzer

In a W4641A interposer setup, you connect the U4208A and U4209A probe cable pods to U4164A logic analyzer pods as per the mapping shown in the table below.

Probe Cable Pods	U4164A Logic Analyzer Pods
U4209A Cable Pods	
Pod A	Pod 1 (signals are dual-sampled on this pod)
Pod B	Pod 5 (signals can be quad-sampled on this pod)
U4208A Cable Pods	
Pod A	Pod 3 (signals are dual-sampled on this pod)
Pod B	Pod 7 (signals can be quad-sampled on this pod)

NOTE

In a dual-sampled setup, the U4164A logic analyzer samples data twice per clock edge. Two thresholds are used with one sample taken per threshold. For DDR systems running less than 2.5GHz, the dual sampling allows separate thresholds and separate sample positions to be specified for DDR Reads and Writes.

In a quad-sampled setup, four samples are taken per clock edge. Two thresholds are used with two samples taken per threshold.

The mapping of the U4208A and U4209A probe cable pods and logic analyzer pods is also illustrated with the help of the following diagram.

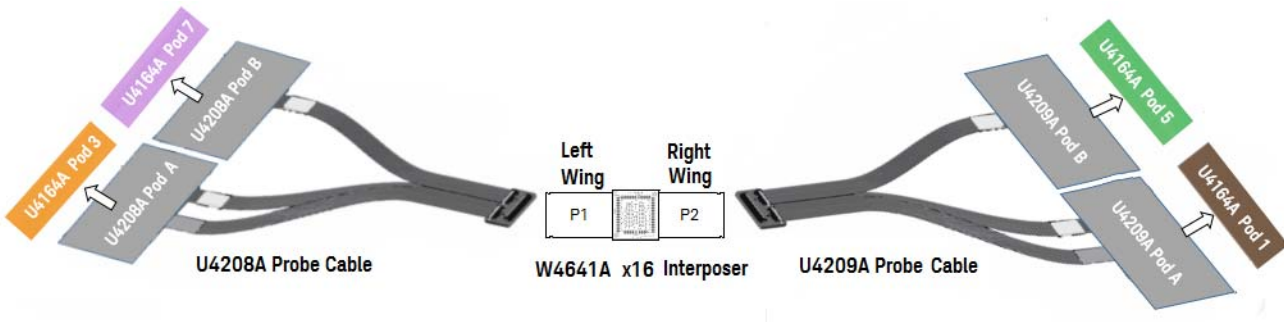


Figure 47 Connections between U4208A and U4209A probe cables and Logic Analyzer pods

Logic Analyzer Channels to Signals Mapping

When you connect the U4208A and U4209A probe cables to a U4164A Logic Analyzer as per the connection diagram in Figure 47, the logic analyzer channels are mapped to DDR4 signals as per the table displayed below.

These signals are automatically configured when you load one of the configuration files supplied with the Keysight B4661A decoder software.

Notes:

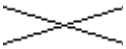
- Clock inputs for each logic analyzer pod are highlighted with yellow in this table.
- Table cells marked with  indicate logic analyzer channels that are not accessible.

Table 11 Signals and Logic Analyzer Channels Mapping when using the W4641A Interposer

Logic Analyzer Pod and its Channels		Signals on U4208A probe cable Pod A
Pod 3 (Signals can be dual-sampled on this pod)	0	A4
	1	A2
	2	A0
	3	A10
	4	PAR
	5	A11
	6	A8
	7	A6
	8	BA0
	9	BG0
	10	ACT_n
	11	ODT
	12	A14
	13	DQSL_t
	14	DMU_n
	15	DMU_n
	CLK	CKE
	CLK#	GND

Logic Analyzer Pod and its Channels		Signals on U4208A probe cable Pod B
Pod 7 (Signals can be quad-sampled on this pod)	0	DQL6
	1	
	2	DQL2
	3	
	4	DQL4
	5	
	6	DQU4
	7	
	8	DQU6
	9	
	10	DQU0
	11	
	12	DQU2
	13	
	14	DQL0
	15	
	CLK	RST_n
	CLK#	GND

Logic Analyzer Pod and its Channels		Signals on U4209A probe cable Pod A
Pod 1 (Signals can be dual-sampled on this pod)	0	A3
	1	
	2	A9
	3	A1
	4	A12
	5	A13
	6	A7
	7	A5
	8	ALERT_n
	9	BA1
	10	A15
	11	
	12	A16
	13	CS_n
	14	DML_n
	15	DML_n
	CLK	CK_t
	CLK#	CK_c

Logic Analyzer Pod and its Channels		Signals on U4209A probe cable Pod B
Pod 5 (Signals can be quad-sampled on this pod)	0	DQL7
	1	
	2	DQL5
	3	
	4	DQL3
	5	
	6	DQU7
	7	
	8	DQU5
	9	
	10	DQU3
	11	
	12	DQU1
	13	
	14	DQL1
	15	
	CLK	DQSU_t
	CLK#	DQSU_c

Signals not probed by the Logic Analyzer

The following signals are omitted from the Logic Analyzer connections for the W4641A interposer.

Interposer	Signal Name
W4641A	VREFCA, TEN, ZQ, DQSL_c

9 Setting Up the Logic Analyzer for W4630-Series and W4640-Series Interposers

KEYSIGHT TECHNOLOGIES

Before You Start

Ensure that all the software components listed in the topic “Hardware and Software Requirements" on page 20 are installed on the host computer and the required software licenses are also obtained and installed.

Loading a Configuration File

The mapping of specific signals to logic analyzer channels depends on:

- Which DRAMs are being probed.
- How SRAM circuit is designed.
- Which interposer is being used.
- How the probe cables and logic analyzer cables are arranged when connecting to the W4630A-series interposer to the logic analyzer module.

Because of these dependencies, there is no single logic analyzer configuration file setup for the W4630-series and W4640-series interposers. A set of DDR4 x4, x8, and x16 configuration files is provided with the Keysight DDR Decoder software. To obtain this set of configuration files, you must install:

- either the B4621B or B4661A memory tools software for the W4630-series interposers. If you have the Logic and Protocol Analyzer software version 6.2 or higher, then it is recommended that you use the latest B4661A software. The B4621B software is used with Logic and Protocol Analyzer software version 6.1 or lower.
- the B4661A software for the W4640-series interposers.

Licensing of these software is not required for obtaining the configurations files. From this set of configuration files, you can load a configuration file that suits your specific requirements in the Logic and Protocol analyzer GUI.

When you load a configuration file, it will set up the buses and signals, add the decoder tool, and add a listing tool in the Logic and Protocol Analyzer GUI.

To load a provided configuration file:

1 Close the logic analyzer GUI window, if it is open.

2 Navigate to the following folder that contains all the DDR configuration files.

Users/Public/Public Documents/Keysight Technologies/Logic Analyzer/Default Configs/Keysight/DDR Bus Decoder

3 Select the DDR bus type.

4 Select the **BGA** and then choose a configuration file corresponding to the bus size and speed.

5 Double-click the configurtion file to open it.

When you click on a configuration file, the Logic and Protocol Analyzer software will start and configure itself to use the decoder.

The logic analyzer Buses/Signals setup dialog allows you to assign descriptive labels to each analyzer channel that associate each channel with the particular DRAM and DRAM signal being probed.

NOTE

If your unique multi-DRAM configuration is not covered by one of the default configurations, you can use the *DDR Custom Configuration Creator* tool installed with the B4661A Memory Analysis SW package to create your own custom DDR BGA configuration.

NOTE

It is recommended that you use the **Advanced Probe Settings (APS)** for all signals on all W4630A series DDR4 BGA interposers. For instructions, refer to the application note "***Capture Highest DDR3 Data rates using Advanced Probe Settings***" available at: http://literature.cdn.keysight.com/litweb/pdf/5991-0799EN.pdf?id=2284314.

To save a configuration file

After you set up the logic analyzer, it is strongly recommended that you save the configuration.

To save your work, select **File>Save As...** and save the configuration as an ALA format file.

ALA format configuration files are more complete and efficient than XML format configuration files. See the Logic and Protocol Analyzer online help for more information on these formats.

10 Characteristics, Regulatory, Safety and Storage Information

Operating Characteristics

The following operating characteristics are not specifications, but are typical operating characteristics.

Characteristics	Description
Temperature	Operating: +5° C to +40° C Non Operating : - 40 ° C to +70° C
Altitude	4,600 m (15,000 ft)
Relative Humidity Range Noncondensing	50% RH Min/80% RH Max at 40° C noncondensing. Avoid sudden, extreme temperature changes which could cause condensation on the circuit board. For indoor use only.

Characteristics	Description
To interposer	Memory bus signals from target system
From interposer	High-density connectors for Keysight U4154A/B and U4164A AXIe-based logic analyzer modules

Storage, Inspection, Baking, and Cleaning Guidelines

The following are some of the guidelines for storing, shelf life, and cleaning of the W4630-series and W4640-series interposers.

Guidelines for Shelf Life and Solder-ability of W4630-series and W4640-series Interposers

If your Interposer exceeds shelf life (1 year) before solder into application, use the following inspection and baking method.

- Inspect the humidity indicator within moisture proof vacuum sealed bag(s).
- If the humidity indicator shows moisture then bake the board at 120 degrees C for 4 hours and perform the solder-ability test.
- If the test passes, proceed with the assembly (reflow) of interposer.
- If delamination occurs, the interposer cannot be used.

Cleaning of W4630-series and W4640-series Interposer Gold Fingers

- Use Isopropyl alcohol to clean interposer contacts.
- Never use abrasive cleaning materials.

Safety Information for the E5849A and E5847A Cable Adapters

To clean the instrument

Do not attempt to clean this product.

Safety Symbols

Safety Symbol	Description
	"Caution" or "Warning" risk of danger marked on product. See "Safety Notices" on page 2 and refer to this manual for a description of the specific danger.
	Hazardous voltage symbol.
	Earth terminal symbol: Used to indicate a circuit common connected to grounded chassis.

Regulatory Notices

WEEE Compliance

Safety Symbol	Description
	This product complies with the WEEE Directive (2002/96/EC) marking requirements. The affixed label indicates that you must not discard this electrical/electronic product in domestic household waste. *Product Category: With reference to the equipment types in the WEEE Directive Annex I, this product is classed as a "Monitoring and Control Instrumentation" product.* **Do not dispose in domestic household waste. To return unwanted products, contact your local Keysight office, or see** "www.keysight.com" for more information.

China RoHS

W4631A, W4633A, W4636A, W4641A, W4643A, E5849A, and E5847A

Index

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KEYSIGHT TECHNOLOGIES

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